



US 20180180944A1

(19) **United States**(12) **Patent Application Publication**
Jang et al.(10) **Pub. No.: US 2018/0180944 A1**(43) **Pub. Date: Jun. 28, 2018**(54) **BACKLIGHT UNIT AND LIQUID CRYSTAL
DISPLAY DEVICE INCLUDING THE SAME****Publication Classification**(71) Applicant: **Samsung Electronics Co., Ltd.**,
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Kang**, Suwon-si (KR); **Oul Cho**,
Suwon-si (KR)(21) Appl. No.: **15/887,015**(22) Filed: **Feb. 2, 2018****Related U.S. Application Data**(63) Continuation of application No. 15/453,948, filed on
Mar. 9, 2017, now Pat. No. 9,933,658, which is a
continuation of application No. 14/010,718, filed on
Aug. 27, 2013, now Pat. No. 9,606,281.(30) **Foreign Application Priority Data**

Sep. 7, 2012 (KR) 10-2012-0099549

(51) **Int. Cl.****G02F 1/1335** (2006.01)**F21V 8/00** (2006.01)(52) **U.S. Cl.**CPC .. **G02F 1/133606** (2013.01); **G02F 1/133603**
(2013.01); **G02F 2202/36** (2013.01); **G02B**
6/005 (2013.01); **G02F 2001/133614**
(2013.01); **G02B 6/0051** (2013.01)

(57)

ABSTRACT

A backlight unit for a liquid crystal display device including a liquid crystal panel, includes: a light source including a light-emitting diode ("ED") which generates and emits light; and a light converting layer between the light source and the liquid crystal panel, spaced apart from the light source, and converting the light from the light source into white light and emitting the white light toward the liquid crystal panel. The light converting layer includes: semiconductor nanocrystals, and a barrier material which restricts penetration of moisture or oxygen.

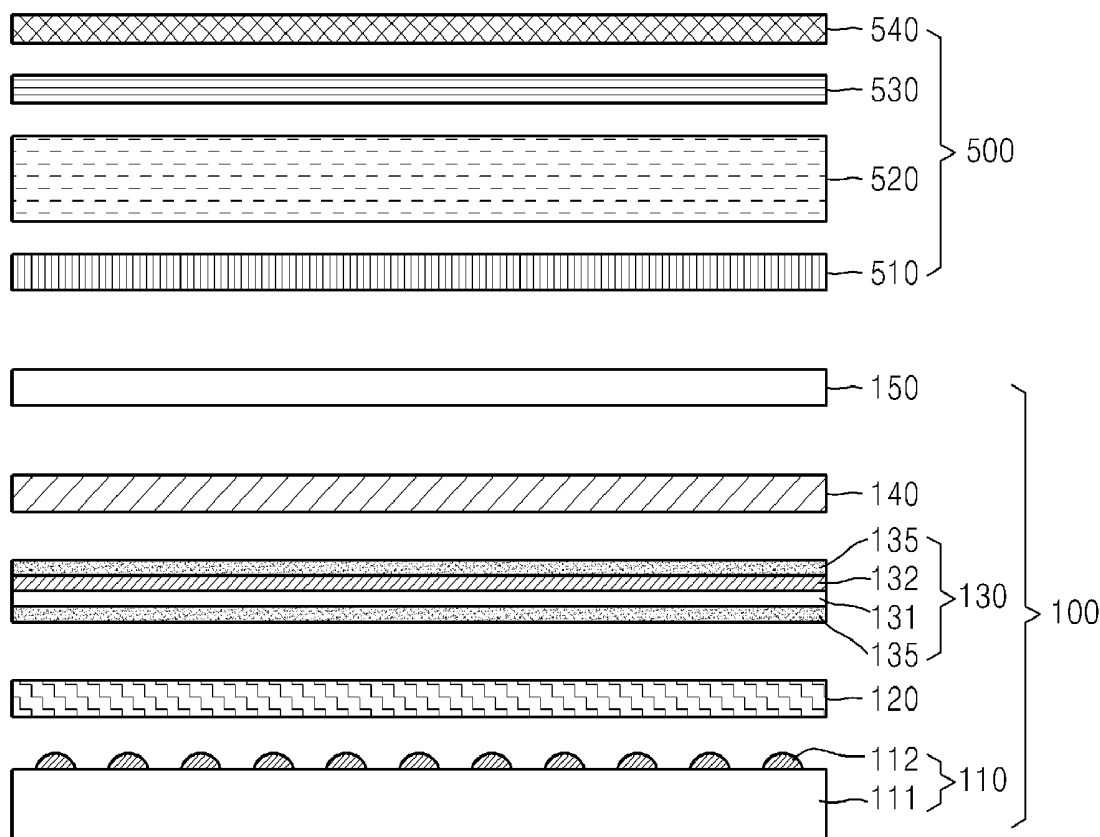


FIG. 1

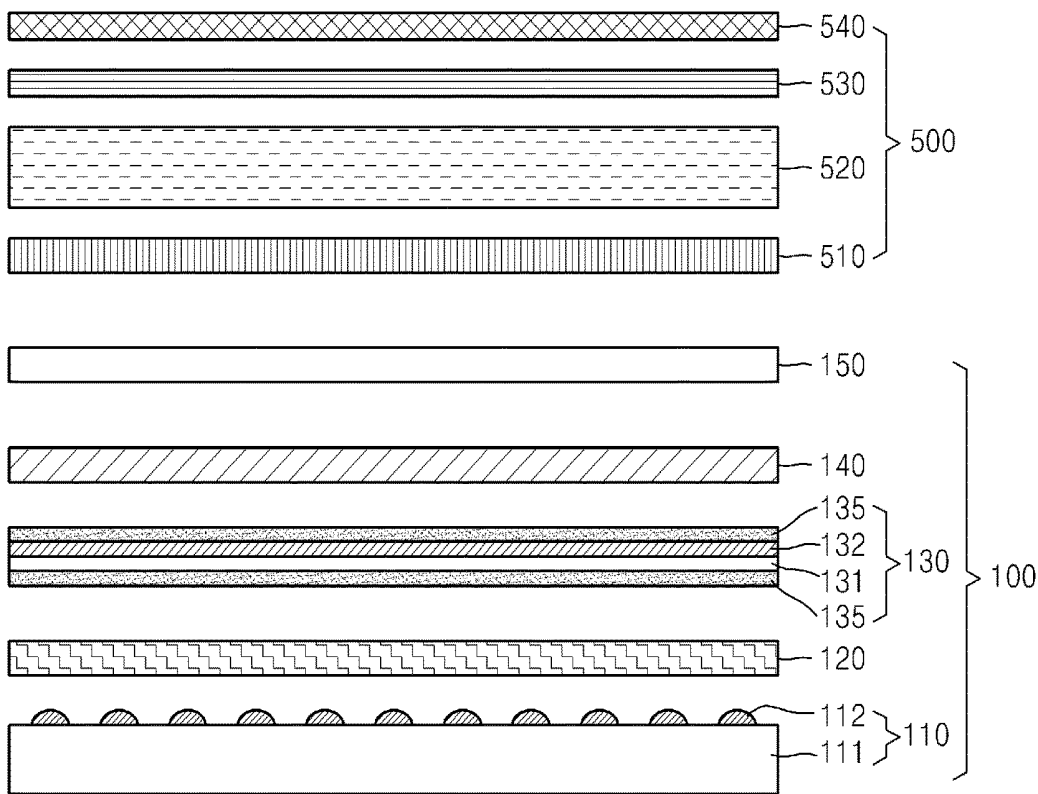


FIG. 2

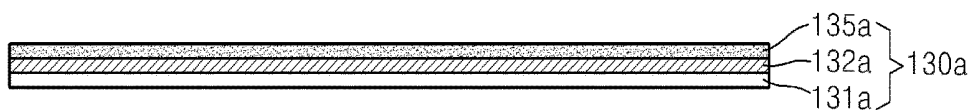


FIG. 3

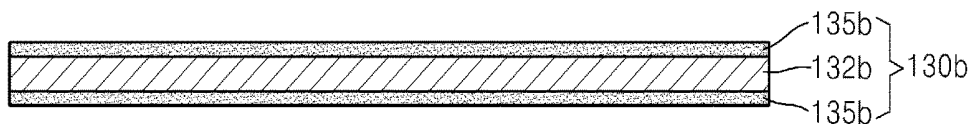


FIG. 4

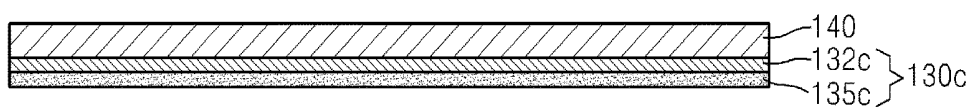


FIG. 5



FIG. 6

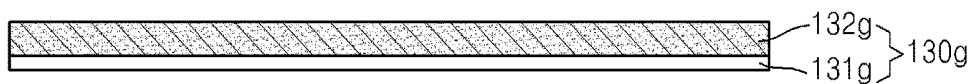


FIG. 7

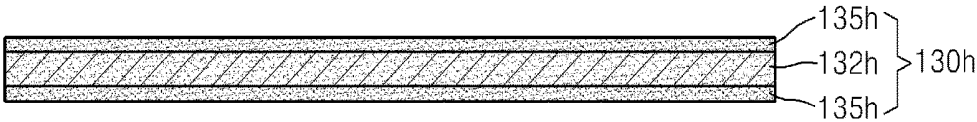


FIG. 8

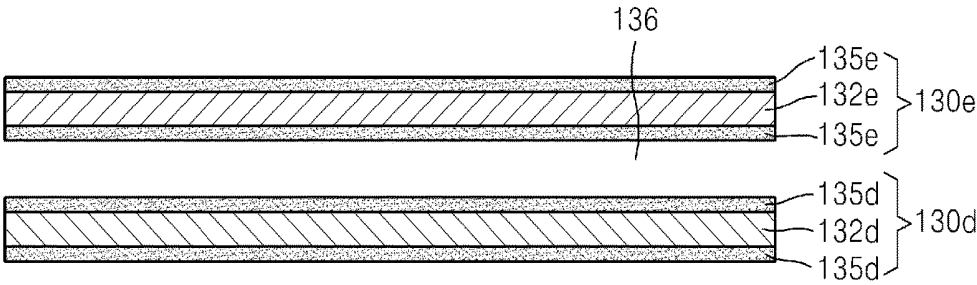


FIG. 9

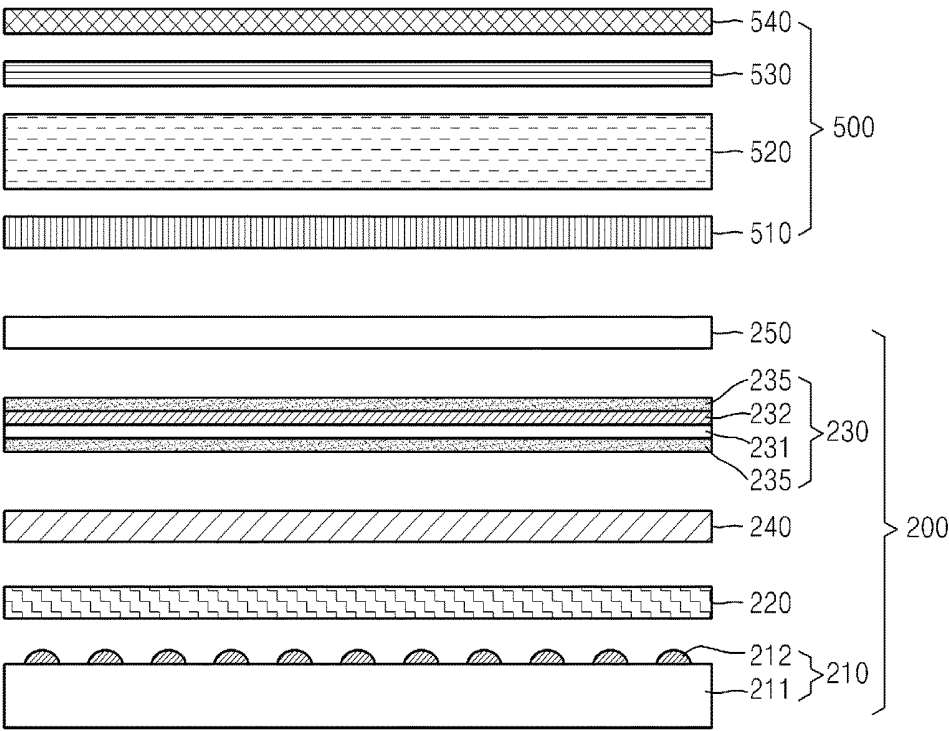


FIG. 10

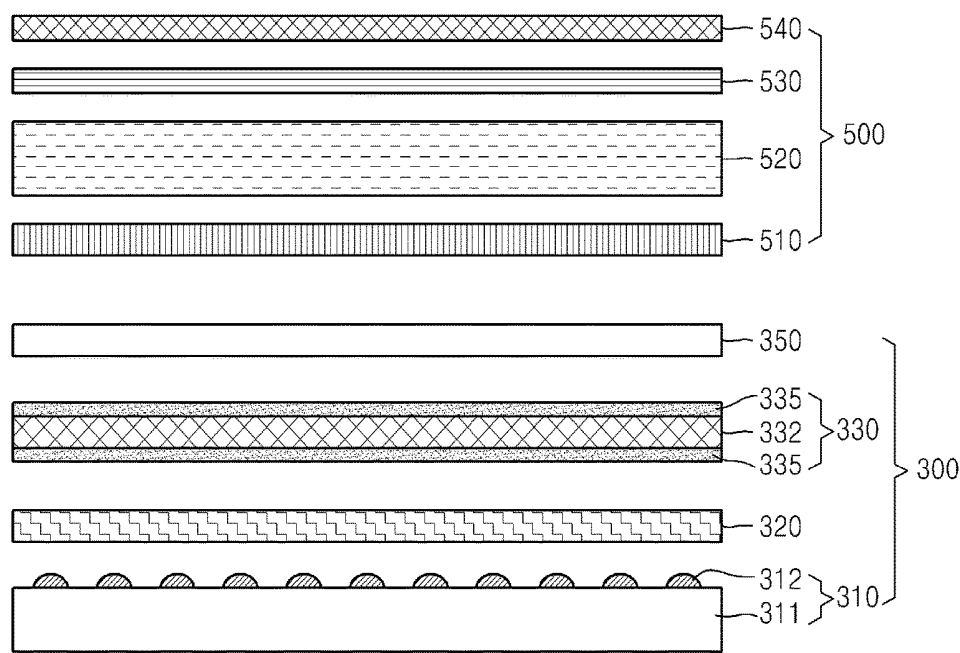


FIG. 11

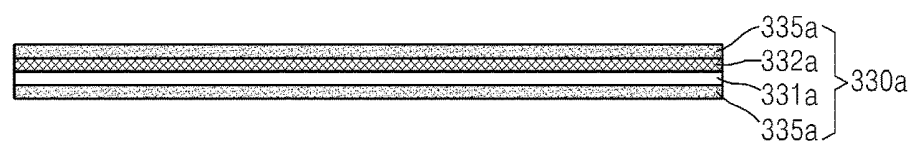


FIG. 12

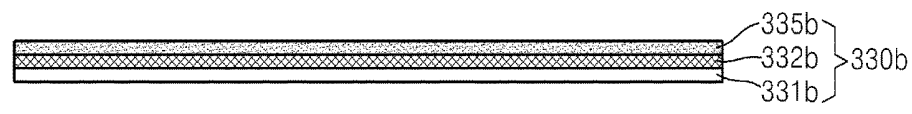


FIG. 13



FIG. 14

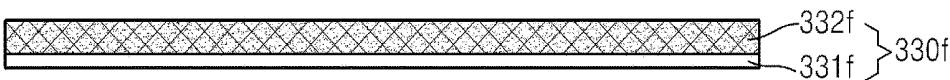


FIG. 15

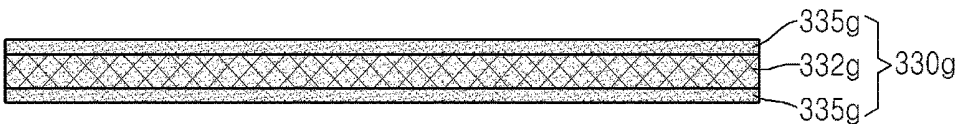


FIG. 16

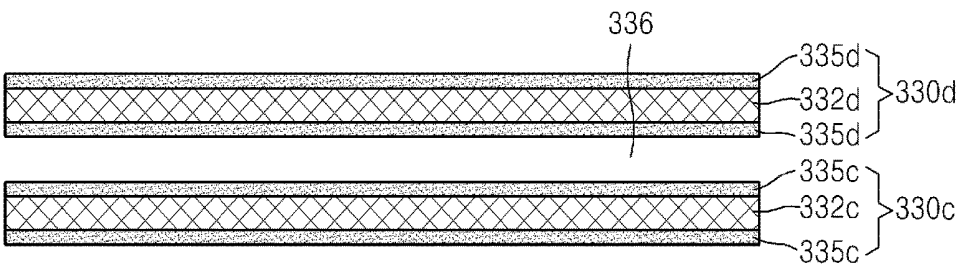


FIG. 17

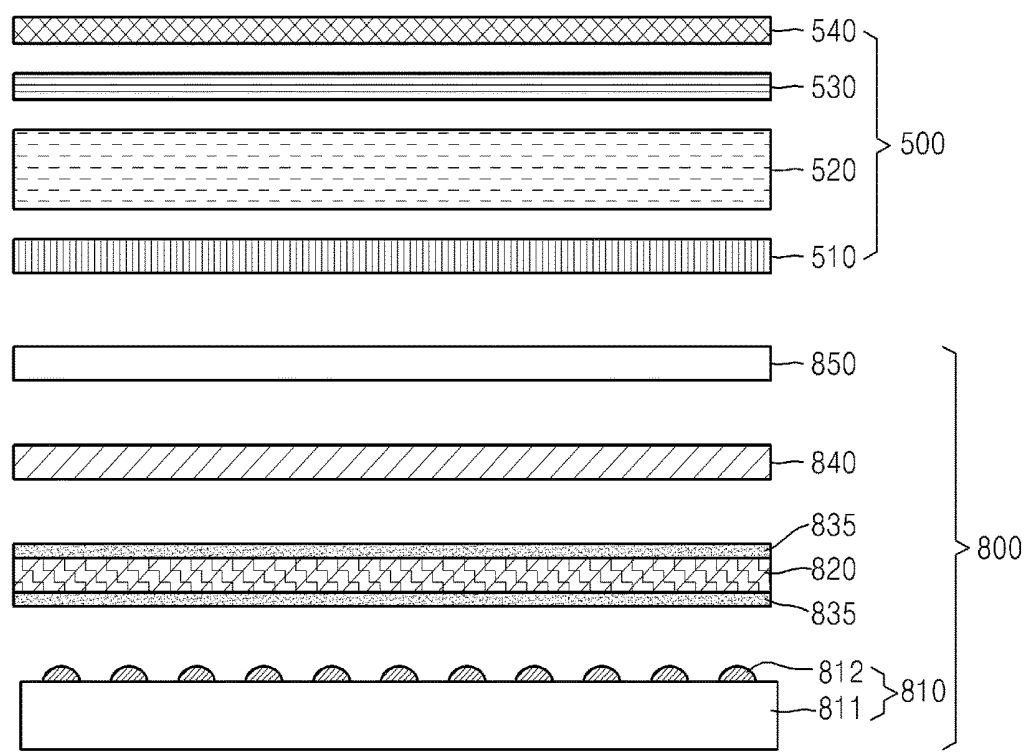


FIG. 18

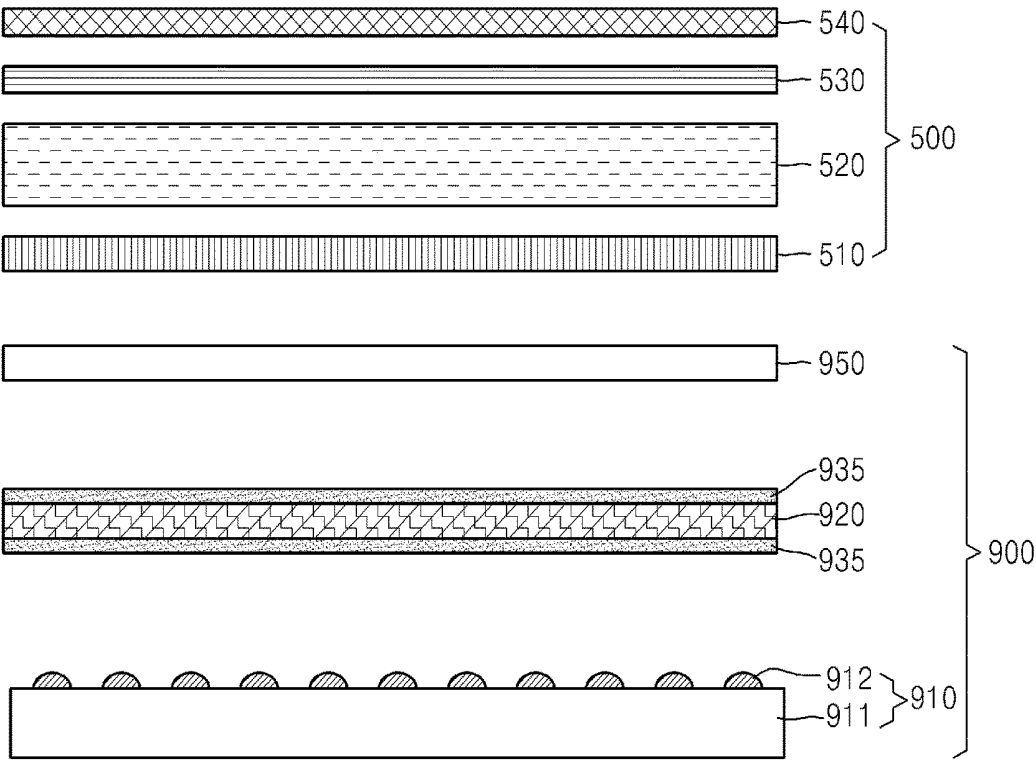


FIG. 19

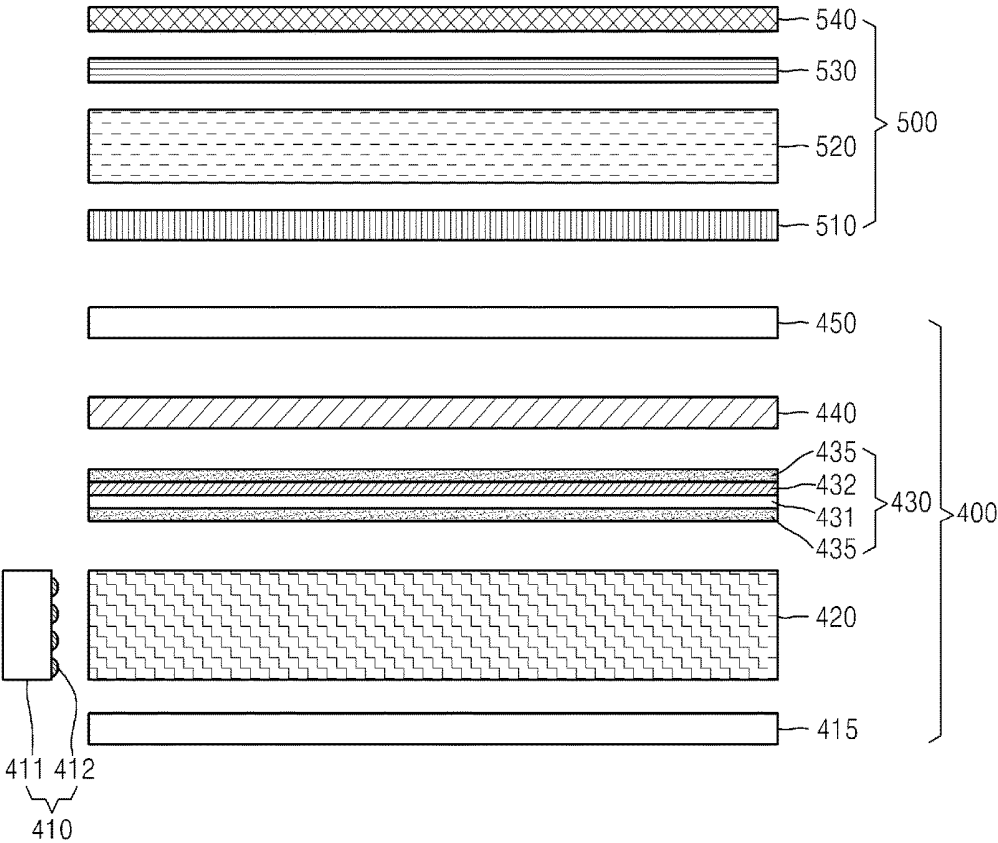


FIG. 20

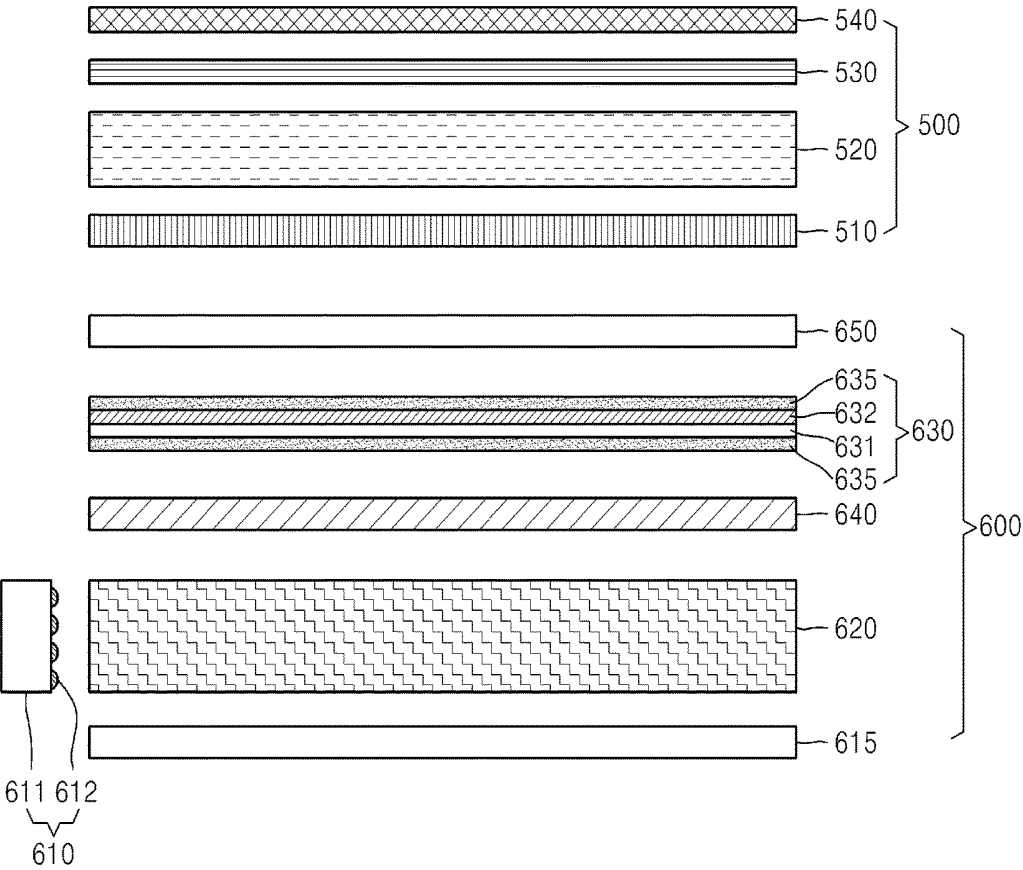


FIG. 21

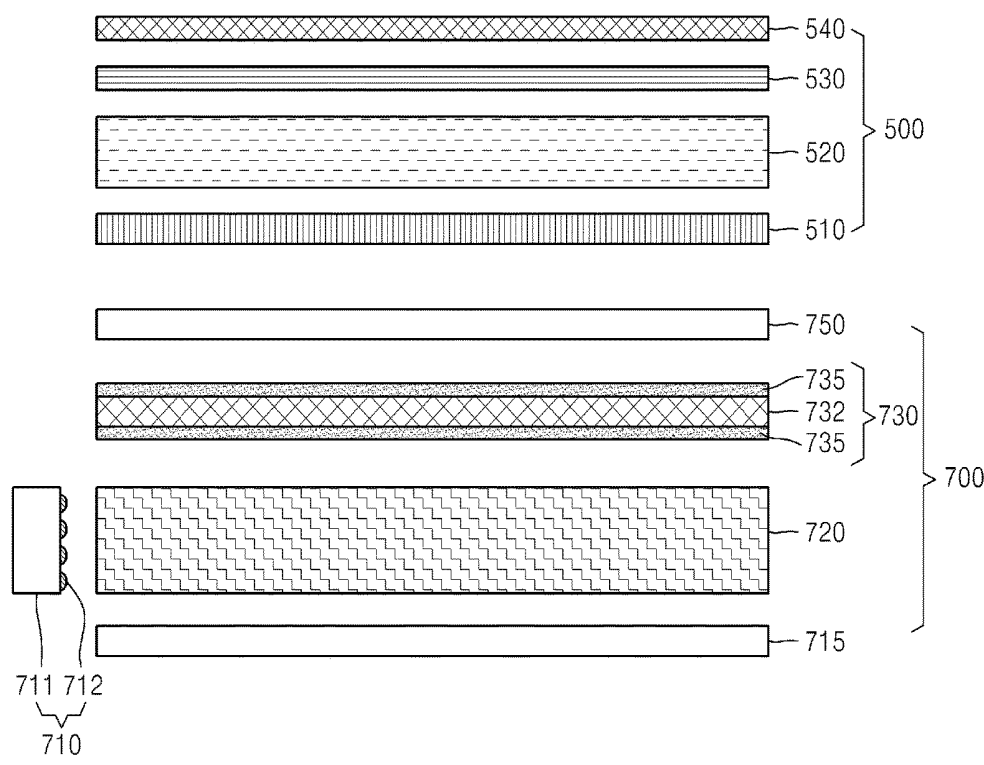


FIG. 22

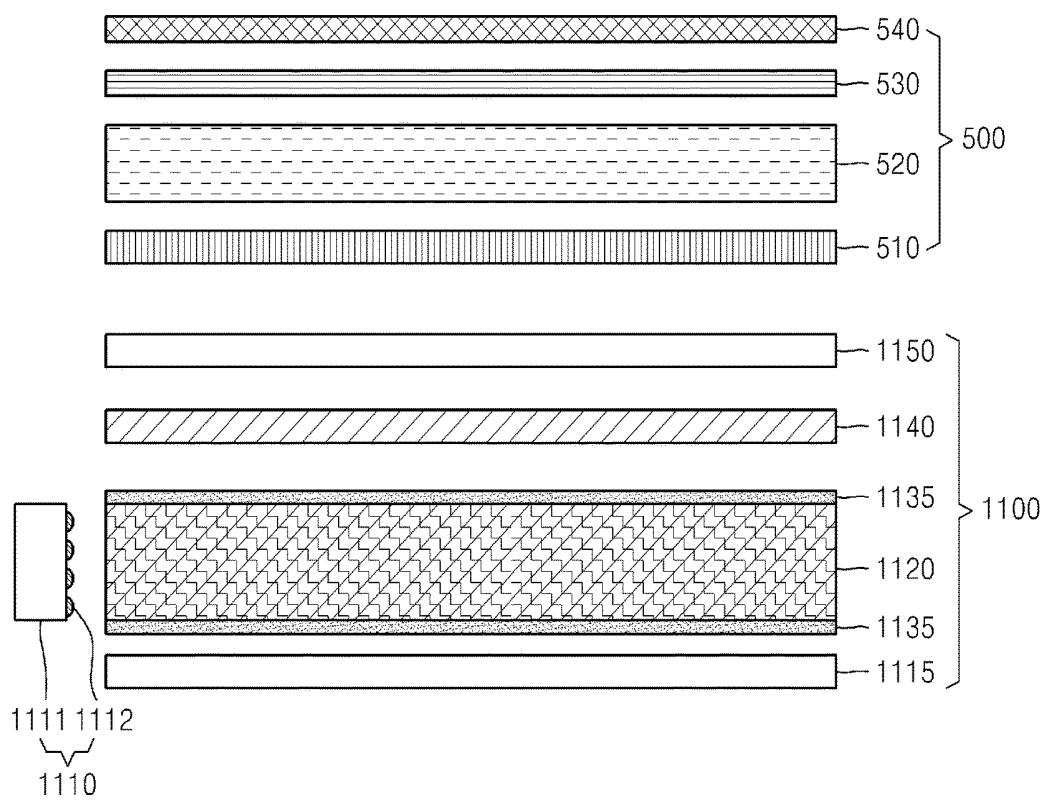
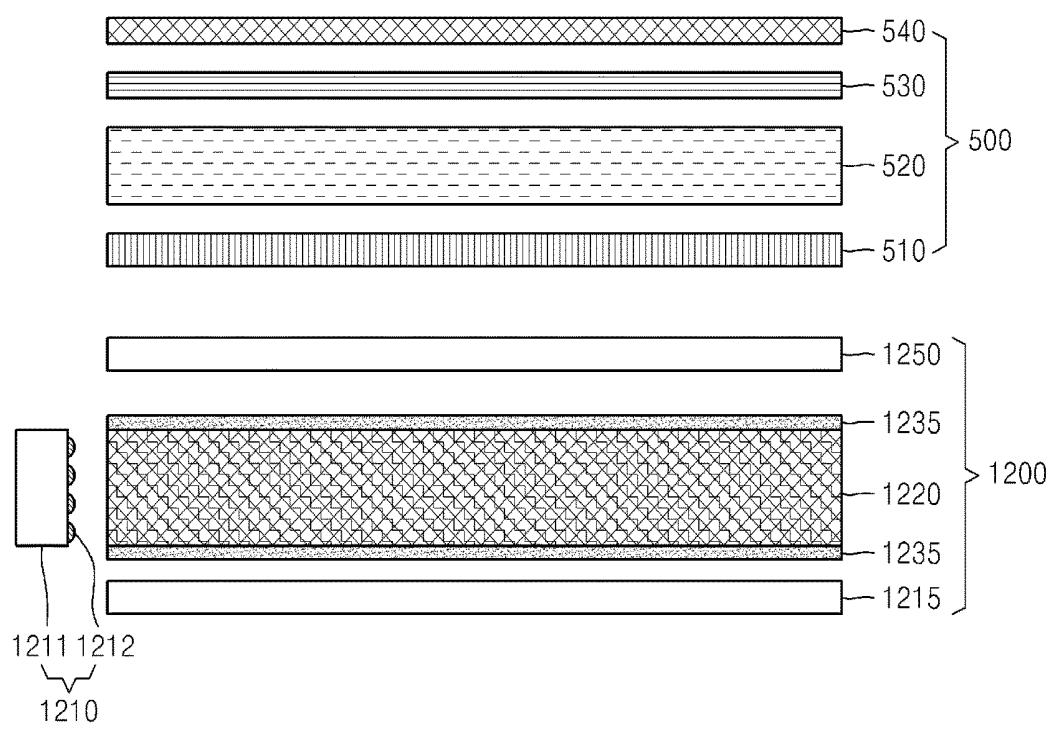


FIG. 23



BACKLIGHT UNIT AND LIQUID CRYSTAL DISPLAY DEVICE INCLUDING THE SAME

CROSS-REFERENCE TO RELATED APPLICATION

[0001] This application is a continuation application of U.S. application Ser. No. 15/453,948 filed Mar. 9, 2017, which is a continuation application of U.S. application Ser. No. 14/010,718 filed Aug. 27, 2013 and issued as U.S. Pat. No. 9,606,281 on Mar. 28, 2017, which claims priority to and the benefit of Korean Patent Application No. 10-2012-0099549, filed on Sep. 7, 2012, in the Korean Intellectual Property Office, the disclosure of which is incorporated herein in its entirety by reference.

BACKGROUND

1. Field

[0002] Provided is a backlight unit using light-emitting diodes (“LEDs”) as a light source and liquid crystal display (“LCD”) devices including the backlight unit.

2. Description of the Related Art

[0003] Unlike plasma display panels (“PDPs”) and field emission display (“FED”) devices, liquid crystal display (“LCD”) devices are light-receiving display devices that may form an image by receiving external light instead of using light generated and emitted therein. Accordingly, LCD devices include backlight units that are disposed on rear surfaces of the LCD devices and emit light.

[0004] Backlight units for conventional LCD devices use cold cathode fluorescent lamps (“CCFLs”) as light sources. However, in this case, color purity may decrease and it is more difficult to achieve uniformity in brightness as sizes of the conventional LCD devices increase.

SUMMARY

[0005] Provided is a backlight unit using light-emitting diodes (“LEDs”) as a light source and a liquid crystal display (“LCD”) device including the backlight unit.

[0006] Additional aspects will be set forth in part in the description which follows and, in part, will be apparent from the description, or may be learned by practice of the presented embodiments.

[0007] Provided is a backlight unit for a LCD device including a liquid crystal panel, including: a light source including a LED which generates and emits light; and a light converting layer between the light source and the liquid crystal panel, and spaced apart from the light source. The light converting layer converts the light from the light source into white light and emits the white light toward the liquid crystal panel. The light converting layer includes semiconductor nanocrystals, and a barrier material which restricts penetration of moisture or oxygen.

[0008] The light converting layer may further include a transparent substrate, a light converting film on a surface of the transparent substrate and including the semiconductor nanocrystals, and a barrier layer on a surface of the light converting film and including the barrier material. The barrier layer may also be on a surface of the transparent substrate, opposite to the surface of the light converting film.

[0009] The light converting layer may further include a light converting film including the semiconductor nanocrystals,

and a barrier layer on a surface of the light converting film and including the barrier material.

[0010] The light converting layer may further include a light converting film including the semiconductor nanocrystals and the barrier material.

[0011] The light converting layer may further include a barrier layer on a surface of the light converting film and including the barrier material.

[0012] The barrier material in the light converting film may restrict penetration of one of the moisture or the oxygen, and the barrier material in the barrier layer may restrict the other of the moisture and the oxygen.

[0013] A moisture transmission rate or an oxygen transmission rate of the barrier material may be equal to or less than about 0.1 cubic centimeter per square meter per day ($\text{cc}/\text{m}^2/\text{day}$).

[0014] The backlight unit may further include a plurality of light converting layers which converts the light into light of different colors. The plurality of light converting layers may be arranged to have an emission wavelength with lower energy as a distance from the light source decreases. The plurality of light converting layers may be spaced apart from one another, and a blank layer may be defined between adjacent light converting layers of the plurality of light converting layers.

[0015] The barrier material may include at least one selected from an organic material and an inorganic material. The barrier material may include the organic material and the inorganic material repeatedly alternated in a stack. The organic material may include at least one selected from thiolene, hybrid epoxy, polyurea, polytetrafluoroethylene (“PTFE”), polydimethylsiloxane (“PDMS”), polyvinylchloride, polycarbonate, polystyrene, polyimide, parylene, polyethylacrylate and polymethylmethacrylate, and the inorganic material may include at least one selected from silicon oxide, aluminum oxide, titanium oxide, indium oxide, tin oxide, indium oxide, tantalum oxide, zirconium oxide and niobium oxide.

[0016] The backlight unit may further include a diffusive plate between the light source and the light converting layer, or between the light converting layer and the liquid crystal panel. The light converting layer may contact a surface of the diffusive plate.

[0017] The light converting layer may further include light diffusing particles which diffuse the light.

[0018] The light converting layer may further include a light-converting diffusive film including the semiconductor nanocrystals and the light diffusing particles, and a barrier layer on a surface of the light-converting diffusive film and including the barrier material.

[0019] The light converting layer may further include a light-converting diffusive film including the semiconductor nanocrystals, the barrier material and the light diffusing particles.

[0020] The light converting layer may further include a barrier layer on a surface of the light-converting diffusive film and including the barrier material.

[0021] An adhesive layer including the barrier material may be on a side surface of the light converting layer.

[0022] The backlight unit may further include a light guide plate between the light source and the light converting layer. The light guide plate guides the light toward the light converting layer.

[0023] The light guide plate may include a light emitting first surface, a second surface opposite to the light emitting first surface, and a side surface connecting the first and second surfaces to each other. The light source may face the side surface of the light guide plate.

[0024] The backlight unit may further include an optical sheet between the light source and the liquid crystal panel. The optical sheet may include at least one selected from a prism sheet, a brightness enhancement sheet and a micro-lens sheet.

[0025] The light source may emit blue light or ultraviolet light. The light source may include a substrate, and a plurality of LEDs on the substrate.

[0026] Provided is a backlight unit for a LCD device including a liquid crystal panel, including: a light source including a LED which generates and emits light; a light guide plate between the light source and the liquid crystal panel, and including semiconductor nanoparticles which convert the light into white light, the light guide plate guiding the light from the light source toward the liquid crystal panel; and a barrier layer on a surface of the light guide plate, and including a barrier material which restricts penetration of moisture or oxygen.

[0027] The light guide plate may include a light emitting first surface, a second surface opposite to the light emitting first surface, and a side surface connecting the first and second surfaces to each other, and the light source may face the side surface of the light guide plate.

[0028] The backlight unit may further include a diffusive plate between the light guide plate and the liquid crystal panel. The light guide plate may further include light diffusing particles which diffuse the light.

[0029] The backlight unit may further include an adhesive layer on a side surface of the light guide plate, and including the barrier material.

[0030] Provided is a LCD device including: a light source including a LED which generates and emits light; a light converting layer spaced apart from the light source, the light converting layer converting the light from the light source into white light and outputting the white light toward a liquid crystal panel, the light converting layer including: semiconductor nanoparticles, and a barrier material which restricts penetration of moisture or oxygen; and the liquid crystal panel which forms an image using the white light from the light converting layer.

[0031] Provided is a LCD device including: a light source comprising a LED which generates and emits light; a light guide plate including semiconductor nanocrystals which convert the light into white light, the light guide plate guiding the light from the light source toward a liquid crystal display panel; a barrier layer on a surface of the light guide plate, and including a barrier material which restricts penetration of moisture or oxygen; and the liquid crystal panel which forms an image using the white light from the light guide plate.

BRIEF DESCRIPTION OF THE DRAWINGS

[0032] These and/or other aspects will become apparent and more readily appreciated from the following description of the embodiments, taken in conjunction with the accompanying drawings in which:

[0033] FIG. 1 is a cross-sectional view illustrating an embodiment of a liquid crystal display ("LCD") device;

[0034] FIG. 2 is a cross-sectional view illustrating another embodiment of a light converting layer of FIG. 1;

[0035] FIG. 3 is a cross-sectional view illustrating another embodiment of the light converting layer of FIG. 1;

[0036] FIG. 4 is a cross-sectional view illustrating another embodiment of the light converting layer of FIG. 1;

[0037] FIG. 5 is a cross-sectional view illustrating another embodiment of the light converting layer of FIG. 1;

[0038] FIG. 6 is a cross-sectional view illustrating another embodiment of the light converting layer of FIG. 1;

[0039] FIG. 7 is a cross-sectional view illustrating another embodiment of the light converting layer of FIG. 1;

[0040] FIG. 8 is a cross-sectional view illustrating another embodiment of the light converting layer of FIG. 1;

[0041] FIG. 9 is a cross-sectional view illustrating another embodiment of an LCD device;

[0042] FIG. 10 is a cross-sectional view illustrating another embodiment of an LCD device;

[0043] FIG. 11 is a cross-sectional view illustrating an embodiment of a light-converting diffusive layer of FIG. 10;

[0044] FIG. 12 is a cross-sectional view illustrating another embodiment of the light-converting diffusive layer of FIG. 10;

[0045] FIG. 13 is a cross-sectional view illustrating another embodiment of the light-converting diffusive layer of FIG. 10;

[0046] FIG. 14 is a cross-sectional view illustrating another embodiment of the light-converting diffusive layer of FIG. 10;

[0047] FIG. 15 is a cross-sectional view illustrating another embodiment of the light-converting diffusive layer of FIG. 10;

[0048] FIG. 16 is a cross-sectional view illustrating another embodiment of the light-converting diffusive layer of FIG. 10;

[0049] FIG. 17 is a cross-sectional view illustrating another embodiment of an LCD device;

[0050] FIG. 18 is a cross-sectional view illustrating another embodiment of an LCD device;

[0051] FIG. 19 is a cross-sectional view illustrating another embodiment of an LCD device;

[0052] FIG. 20 is a cross-sectional view illustrating another embodiment of an LCD device;

[0053] FIG. 21 is a cross-sectional view illustrating another embodiment of an LCD device;

[0054] FIG. 22 is a cross-sectional view illustrating another embodiment of an LCD device; and

[0055] FIG. 23 is a cross-sectional view illustrating another embodiment of an LCD device.

DETAILED DESCRIPTION

[0056] It will be understood that when an element or layer is referred to as being "on" or "coupled to" another element or layer, the element or layer can be directly on or connected to another element or layer or intervening elements or layers. In contrast, when an element is referred to as being "directly on" or "directly connected to" another element or layer, there are no intervening elements or layers present. Like numbers refer to like elements throughout. As used herein, the term "and/or" includes any and all combinations of one or more of the associated listed items. Expressions such as "at least one" and "at least one selected from," when

preceding a list of elements, modify the entire list of elements and do not modify the individual elements of the list.

[0057] The invention will now be described more fully with reference to the accompanying drawings, in which embodiments of the invention are shown. In the drawings, the same reference numerals denote the same elements, and sizes of thicknesses of elements may be exaggerated for clarity.

[0058] It will be understood that, although the terms first, second, third, etc., may be used herein to describe various elements, components, regions, layers and/or sections, these elements, components, regions, layers and/or sections should not be limited by these terms. These terms are only used to distinguish one element, component, region, layer or section from another region, layer or section. Thus, a first element, component, region, layer or section discussed below could be termed a second element, component, region, layer or section without departing from the teachings of the invention.

[0059] Spatially relative terms, such as “lower,” “under,” “above,” “upper” and the like, may be used herein for ease of description to describe the relationship of one element or feature to another element(s) or feature(s) as illustrated in the figures. It will be understood that the spatially relative terms are intended to encompass different orientations of the device in use or operation, in addition to the orientation depicted in the figures. For example, if the device in the figures is turned over, elements described as “lower” or “under” relative to other elements or features would then be oriented “above” relative to the other elements or features. Thus, the exemplary term “under” can encompass both an orientation of above and below. The device may be otherwise oriented (rotated 90 degrees or at other orientations) and the spatially relative descriptors used herein interpreted accordingly.

[0060] The terminology used herein is for the purpose of describing particular embodiments only and is not intended to be limiting of the invention. As used herein, the singular forms “a,” “an” and “the” are intended to include the plural forms as well, unless the context clearly indicates otherwise. It will be further understood that the terms “comprises,” “comprising,” “includes” and/or “including,” when used in this specification, specify the presence of stated features, integers, operations, elements, and/or components, but do not preclude the presence or addition of one or more other features, integers, steps, operations, elements, components, and/or groups thereof.

[0061] Embodiments of the invention are described herein with reference to cross-section illustrations that are schematic illustrations of idealized embodiments (and intermediate structures) of the invention. As such, variations from the shapes of the illustrations as a result, for example, of manufacturing techniques and/or tolerances, are to be expected. Thus, embodiments of the invention should not be construed as limited to the particular shapes of regions illustrated herein but are to include deviations in shapes that result, for example, from manufacturing.

[0062] Unless otherwise defined, all terms (including technical and scientific terms) used herein have the same meaning as commonly understood by one of ordinary skill in the art to which this invention belongs. It will be further understood that terms, such as those defined in commonly used dictionaries, should be interpreted as having a meaning

that is consistent with their meaning in the context of the relevant art and will not be interpreted in an idealized or overly formal sense unless expressly so defined herein.

[0063] Hereinafter, the invention will be described in detail with reference to the accompanying drawings.

[0064] Backlight units may include three color light emitting diodes (“LEDs”) as light sources. Backlight units using three color LEDs as light sources may be applied to high quality display devices because the backlight units using three color LEDs may obtain high color purity. However, backlight units using three color LEDs as light sources are undesirably more expensive than backlight units using cold cathode fluorescent lamps (“CCFLs”) as light sources.

[0065] In order to reduce costs, white LEDs that convert light output from an LED chip of one color into white light and output the white light have been developed. However, although such white LEDs may reduce costs, the white LEDs have lower color purity and lower color reproducibility than three color LEDs. Accordingly, there remains a need for a backlight unit with improved color reproducibility and color purity, and cost competitiveness.

[0066] FIG. 1 is a cross-sectional view illustrating an embodiment of a liquid crystal display (“LCD”) device.

[0067] Referring to FIG. 1, the LCD device includes a backlight unit 100, and a liquid crystal panel 500 that forms an image of a specific color by using white light emitted from the backlight unit 100. The backlight unit 100 includes a LED light source 110, and a light converting layer 130. The light converting layer 130 converts light emitted from the LED light source 110 into white light and outputs the white light to the liquid crystal panel 500. The LED light source 110 may include a substrate 111, and a plurality of LEDs 112 that is disposed at predetermined intervals on the substrate 111. The LED light source 110 may be a light source that emits blue light. However, the present embodiment is not limited thereto, and the LED light source 110 may be a light source that emits ultraviolet light.

[0068] The light converting layer 130 is disposed between the LED light source 110 and the liquid crystal panel 500, and is spaced apart from the LED light source 110 by a predetermined distance. Each of the LED light source 110 and the light converting layer 130 may have a planar size corresponding to the liquid crystal panel 500, such as in a plane view of the LCD device from a viewing side and/or a rear side thereof.

[0069] The light converting layer 130 may include a transparent substrate 131, a light converting film 132 that is disposed such as by coating on the transparent substrate 131 and includes semiconductor nanocrystals, and a barrier layer 135 that is disposed on a top surface of the light converting film 132 and includes a barrier material. The transparent substrate 131 may include, but is not limited to, a resin such as polyethylene terephthalate (“PET”).

[0070] The light converting film 132 converts light emitted from the LED light source 110 into white light. The light converting film 132 may include semiconductor nanocrystals that may obtain high color reproducibility and high color purity. For example, the semiconductor nanocrystals may include at least one selected from a Group II-VI material, a Group III-V material, and a Group IV element. The term “Group” refers to a group of the Periodic Table of the Elements. The Group II-VI material, and Group III-V material may each independently include at least one selected from a binary compound, a ternary compound, and a qua-

ternary compound. The Group II-VI material may include at least one selected from HgTe, HgSe, HgS, CdTe, CdSe, CdS, ZnTe, ZnSe, ZnS, CdSeS, CdSeTe, CdSTe, ZnSeS, ZnSeTe, ZnSTe, HgSeS, HgSeTe, HgSTe, CdZnS, CdZnSe, CdZnTe, CdHgS, CdHgSe, CdHgTe, HgZnS, HgZnSe, HgZnTe, MgZnSe, MgZnS, HgZnTeS, CdZnSeS, CdZnSeTe, CdZnSTe, CdHgSeS, CdHgSeTe, CdHgSTe, HgZnSeS, HgZnSeTe, and HgZnSTe; the Group III-V material may include at least one selected from GaN, GaP, InN, InP, InAs, GaNP, GaNAs, GaNSb, GaPAs, GaPSb, AlNP, AlNAs, AlNSb, AlPAs, AlPSb, InNP, InNAs, InNSb, InPAs, InPSb, GaAlNP, GaAlNAs, GaAlNSb, GaAlPAs, GaAlPSb, GaInNP, GaInNAs, GaInNSb, GaInPAs, GaInPSb, InAlNP, InAlNAs, InAlNSb, InAlPAs, and InAlPSb; and the Group IV element may include at least one selected from Si and Ge. The materials are exemplarily described as materials of the semiconductor nanocrystals, and other various semiconductor materials may be used as materials for the semiconductor nanocrystals. The light converting film 132 may be, for example, a polymer film in which the semiconductor nanocrystals are dispersed.

[0071] The barrier layer 135 may be disposed on a top surface of the light converting film 132, toward the viewing side of the LCD. The barrier layer 135 restricts penetration of moisture and/or oxygen thereto, such that the barrier layer 135 reduces or effectively prevents external moisture and/or oxygen from penetrating into the light converting film 132. In detail, the light converting film 132 including the semiconductor nanocrystals reacts with ambient oxygen or moisture when receiving light from the LED light source 110 and converting the light, to thereby cause a physicochemical change. Accordingly, as time passes, optical properties of the light converting film 132, for example, a wavelength, a full width at half maximum, or quantum efficiency, may be undesirably changed. In order to maintain optical properties of the light converting film 132, the barrier layer 135 is disposed on the top surface of the light converting film 132 in FIG. 1. When the transparent substrate 131 includes a material into which moisture or oxygen may penetrate, for example, PET, the barrier layer 135 may also be disposed on the bottom surface of the transparent substrate 131.

[0072] Each of moisture and oxygen transmission rates of the barrier layer 135 may be equal to or less than, for example, about 0.1 cubic centimeter per square meter per day (cc/m²/day). However, the present embodiment is not limited thereto, and each of the moisture and oxygen transmission rates of the barrier layer 135 may be another value which sufficiently restricts the moisture and the oxygen, respectively.

[0073] The barrier material of the barrier layer 135 may include at least one selected from an organic material and an inorganic material. The organic material may include at least one selected from, for example, thiolene, hybrid epoxy, polyurea, polytetrafluoroethylene ("PTFE"), polydimethylsiloxane ("PDMS"), polyvinylchloride, polycarbonate, polystyrene, polyimide, parylene, polyethylacrylate, and polymethylmethacrylate. The inorganic material may include at least one selected from, for example, silicon oxide, aluminum oxide, titanium oxide, indium oxide, tin oxide, tin indium oxide, tantalum oxide, zirconium oxide, and niobium oxide. However, the present embodiment is not limited thereto, and any of various other organic materials or inorganic materials may be used as the barrier material. The barrier layer 135 may have a structure in which at least one

organic film and at least one inorganic film alternate in a stack. In this case, the organic film may include epoxy, acrylate, or urethane other than the above organic materials.

[0074] When a general or conventional backlight unit that does not include the barrier layer 135 is driven for a long time, for example, 100 hours or more, at a temperature higher than a room temperature, brightness of white light may be reduced by 10% or more, a change (ΔC_x , ΔC_y) in color coordinates may be greater than (± 0.1 , ± 0.1), or a change in a color temperature may be 1000 degrees Kelvin ($^{\circ}$ K) or more. However, when the backlight unit 100 including the barrier layer 135 whose moisture transmission rate and oxygen transmission rates are each equal to or less than about 0.1 cc/m²/day is driven for a long time, for example, 100 hours or more, at a temperature higher than a room temperature, brightness of white light may be maintained, a change (ΔC_x , ΔC_y) in color coordinates may be less than (± 0.1 , ± 0.1), and/or a change in a color temperature may be 1000 $^{\circ}$ K or less. Accordingly, even after a relatively long operation, since brightness and color coordinates are not greatly changed, the backlight unit 100 may ensure high reliability.

[0075] An adhesive layer (not shown) including the barrier material may be further disposed on a side surface of the light converting layer 130. The adhesive layer may surround side surface of the light converting layer 130. Due to the adhesive layer, edge portions of layers constituting the light converting layer 130 may be considered laminated.

[0076] The barrier material included in the adhesive layer reduces or effectively prevents external moisture and/or oxygen from penetrating into the side surface of the light converting layer 130. The adhesive layer may have an uneven (e.g., non-uniform thickness) structure corresponding to the edge portions of the layers constituting the light converting layer 130, or a multi-layer structure which is disposed on a film. The barrier material may include at least one selected from an organic material and an inorganic material. As described above, the organic material may include at least one selected from, for example, thiolene, hybrid epoxy, polyurea, PTFE, PDMS, polyvinylchloride, polycarbonate, polystyrene, polyimide, parylene, polyethylacrylate, and polymethylmethacrylate. The inorganic material may include at least one selected from, for example, silicon oxide, aluminum oxide, titanium oxide, indium oxide, tin oxide, tin indium oxide, tantalum oxide, zirconium oxide, and niobium oxide.

[0077] FIG. 2 is a cross-sectional view illustrating another embodiment of the light converting layer 130 of FIG. 1. Referring to FIG. 2, a light converting layer 130a may include a transparent substrate 131a, a light converting film 132a that is coated on the transparent substrate 131a and includes semiconductor nanocrystals, and a barrier layer 135a that is disposed on an upper surface of the light converting film 132a and includes a barrier material. The transparent substrate 131a may be a substrate that may reduce or effectively prevent penetration of external moisture or oxygen thereto, such as a glass substrate. In this case, the barrier layer 135a may not be disposed on a bottom surface of the transparent substrate 131a.

[0078] FIG. 3 is a cross-sectional view illustrating another embodiment of the light converting layer 130 of FIG. 1. Referring to FIG. 3, a light converting layer 130b may include a light converting film 132b that includes semiconductor nanocrystals, and a barrier layer 135b that is disposed

on a surface of the light converting film **132b**. In this case, the light converting layer **130b** may not include the transparent substrate **131** of FIG. 1. The barrier layer **135b** may be disposed on one or both of the upper and lower surfaces of the light converting film **132b**.

[0079] FIG. 5 is a cross-sectional view illustrating another embodiment of the light converting layer **130** of FIG. 1. Referring to FIG. 5, a light converting layer **130f** may include a light converting film **132f** that includes semiconductor nanocrystals and a barrier material. The light converting film **132f** may be a single-layer film including both the semiconductor nanocrystals and the barrier material. The light converting film **132f** of FIG. 5 converts incident light into white light, and reduces or effectively prevents penetration of external moisture and oxygen thereto. Each of moisture and oxygen transmission rates of the light converting film **132f** may be equal to or less than, for example, about 0.1 cc/m²/day.

[0080] FIG. 6 is a cross-sectional view illustrating another embodiment of the light converting layer **130** of FIG. 1. Referring to FIG. 6, a light converting layer **130g** may include a transparent substrate **131g**, and a light converting film **132g** that is disposed on the transparent substrate **131g** and includes semiconductor nanocrystals and a barrier material.

[0081] FIG. 7 is a cross-sectional view illustrating another embodiment of the light converting layer **130** of FIG. 1. Referring to FIG. 7, a light converting layer **130h** may include a light converting film **132h** that includes semiconductor nanocrystals and a barrier material, and a barrier layer **135h** on a surface of the light converting film **132h** and includes a barrier material. The barrier layer **135h** may be disposed on one or both of the upper and lower surfaces of the light converting film **132h**. The barrier layer **135h** may reduce or effectively prevent penetration of moisture or oxygen, and the light converting film **132h** may reduce or effectively prevent penetration of the remaining one of moisture and oxygen.

[0082] Also, the aforesaid adhesive layer (not shown) may be further disposed on a side surface of each of the above light converting layers.

[0083] FIG. 8 is a cross-sectional view illustrating another embodiment of the light converting layer **130** of FIG. 1. Referring to FIG. 8, the LCD device may include a plurality of light converting layers sequentially disposed in a direction away from the LED light source **110**. The plurality of light converting layers may collectively form a light converting member of the LCD device. In detail, first and second light converting layers **130d** and **130e** are sequentially disposed in a direction away from the LED light source **110**.

[0084] The first light converting layer **130d** may include a first light converting film **132d**, and a first barrier layer **135d** that is disposed on one or more surface of the first light converting film **132d**. The second light converting layer **130e** may include a second light converting film **132e**, and a second barrier layer **135e** that is disposed on one or more surface of the second light converting film **132e**.

[0085] The first light converting layer **130d** and the second light converting layer **130e** may be spaced apart from each other in a cross-section direction, and a blank layer **136** may be defined between the first light converting layer **130d** and the second light converting layer **130e**. The first and second light converting layers **130d** and **130e** may be disposed to

have an emission wavelength with higher energy (that is, a shorter wavelength) as a distance from the LED light source **110** towards the viewing side of the LCD device increases. In one embodiment, for example, when the LED light source **110** is a blue LED light source, the first and second light converting layers **130d** and **130e** that are sequentially disposed in a direction away from the LED light source **110** may be a red light converting layer and a green light converting layer, respectively.

[0086] Alternatively, the LCD device or a light converting member may include three or more sequential light converting layers. The three or more sequential light converting layers may have any of the following arrangement structures. In alternative embodiments, for example, the light converting layers may have an arrangement structure of the LED light source **110**—red light converting layer—green light converting layer—red light converting layer—green light converting layer, an arrangement structure of the LED light source **110**—green light converting layer—red light converting layer—green light converting layer—red light converting layer, an arrangement structure of the LED light source **110**—red light converting layer—orange light converting layer—yellow light converting layer—green light converting layer, or an arrangement structure of the LED light source **110**—red+yellow light converting layer—green+orange light converting layer. The arrangement structures of the three or more sequential light converting layers described above are exemplary and the three or more sequential light converting layers may have any of various other arrangement structures.

[0087] Referring back to FIG. 1, when light emitted from the LED light source **110** passes through the light converting film **132** including the semiconductor nanocrystals, white light which is a mixture of blue light, green light and red light may be obtained. When compositions and/or sizes of the semiconductor nanocrystals included in the light converting film **132** are changed, blue light, green light and red light may be adjusted at a desired ratio, and thus white light having high color reproducibility and high color purity may be obtained.

[0088] A light guide plate **120** may be further disposed between the LED light source **110** and the light converting layer **130**. The light guide plate **120** uniformly guides light output from the LED light source **110** toward the light converting layer **130**. The light guide plate **120** may include an upper surface as a light emitting surface, a lower surface as a light incident surface, and a plurality of side surfaces connecting the upper and lower surfaces to each other. The surface of the light guide plate **120** which faces the LED light source **110** may be a light incident surface of the light guide plate **120**. A diffusive plate **140** may be further disposed between the light converting layer **130** and the liquid crystal panel **500**. The diffusive plate **140** diffuses white light incident from the light converting layer **130** and outputs the white light. Accordingly, uniformity of the white light passing through the diffusive plate **140** may be improved.

[0089] Although the diffusive plate **140** and the light converting layer **130** are spaced apart from each other in FIG. 1, the light converting layer **130** may contact a bottom surface of the diffusive plate **140** as shown in FIG. 4. In this case, a light converting layer **130c** may include a light converting film **132c** that is disposed on the bottom surface of the diffusive plate **140** and includes semiconductor nanoc-

rystals, and a barrier layer **135c** that is disposed on a bottom surface of the light converting film **132c** and includes a barrier material.

[0090] A predetermined optical sheet **150** for improving optical properties such as brightness may be further disposed between the diffusive plate **140** and the liquid crystal panel **500**. The optical sheet **150** may include at least one selected from, for example, a prism sheet, a brightness enhancement sheet and a micro-lens sheet. However, the present embodiment is not limited thereto, and the optical sheet **150** may include any number of sheets having various other functions. Alternatively, the optical sheet **150** may be disposed between the LED light source **110** and the light converting layer **130**.

[0091] White light emitted from the backlight unit **100** is incident on the liquid crystal panel **500**. The liquid crystal panel **500** forms an image of a predetermined color by using the white light incident from the backlight unit **100**. The liquid crystal panel **500** may have a structure in which a first polarization plate **510**, a liquid crystal layer **520**, a second polarization plate **530**, and a color filter **540** are sequentially disposed. White light emitted from the backlight unit **100** transmits through the first polarization plate **510**, the liquid crystal layer **520** and the second polarization plate **530** and then is incident on the color filter **540** to form the image of the predetermined color.

[0092] Since the light converting film **132** of the light converting layer **130** includes the semiconductor nanocrystals, the backlight unit **110** constructed as described above may improve color reproducibility and color purity. Since the light converting film **132** is spaced apart from the LED light source **110**, deterioration of the semiconductor nanocrystals due to heat generated from the LEDs **112** is reduced or effectively prevented. Also, since the barrier layer **135** is disposed on the light converting film **132**, penetration of external moisture and oxygen into the light converting film **132** may be reduced or effectively prevented. Accordingly, when the light converting film **132** converts light incident from the LED light source **110** into white light, optical properties such as a wavelength, a full width at half maximum and quantum efficiency may not be changed, and thus brightness and color coordinates of the backlight unit **100** may be maintained even when the backlight unit **100** is driven for a long time.

[0093] FIG. 9 is a cross-sectional view illustrating another embodiment of an LCD device. The following explanation will focus on a difference from the previous embodiment.

[0094] Referring to FIG. 9, a backlight unit **200** includes an LED light source **210**, and a light converting layer **230**. The light converting layer **230** converts light incident from the LED light source **210** into white light and outputs the white light to the liquid crystal panel **500**. The light converting layer **230** is disposed between the LED light source **210** and the liquid crystal panel **500**, and is spaced apart from the LED light source **210**. The LED light source **210** may be a light source that emits blue light, or the LED light source **210** may be a light source that emits ultraviolet light. The LED light source **210** may include a substrate **211**, and a plurality of LEDs **212** that is disposed at predetermined intervals on the substrate **211**.

[0095] The light converting layer **230** may include a transparent substrate **231**, a light converting film **232** that is disposed such as by coating on the transparent substrate **231** and includes semiconductor nanocrystals, and a barrier layer

235 that is disposed on a top surface of the light converting film **232** and includes a barrier material. The transparent substrate **231** may include, but is not limited to, a resin such as PET. The barrier layer **235** reduces or effectively prevents external moisture and/or oxygen from penetrating into the light converting film **232** as described above. When the transparent substrate **231** includes a material into which moisture or oxygen may penetrate such as PET, the barrier layer **235** may also be disposed on the bottom surface of the transparent substrate **231**.

[0096] Each of moisture and oxygen transmission rates of the barrier layer **235** may be, but is not limited to, equal to or less than about 0.1 cc/m²/day. The barrier material of the barrier layer **235** may include at least one selected from an organic material and an inorganic material. The organic material may include at least one selected from, for example, thiolene, hybrid epoxy, polyurea, PTFE, PDMS, polyvinylchloride, polycarbonate, polystyrene, polyimide, parylene, polyethylacrylate, and polymethylmethacrylate. The inorganic material may include at least one selected from, for example, silicon oxide, aluminum oxide, titanium oxide, indium oxide, tin oxide, tin indium oxide, tantalum oxide, zirconium oxide, and niobium oxide. However, the present embodiment is not limited thereto, and any of various other organic materials or inorganic materials may be used as the barrier material. The barrier layer **235** may have a structure in which at least one organic film and at least one inorganic film alternate in a stack.

[0097] Alternatively, any of the light converting layers shown in FIGS. 2, 3 and 5-7 may be used as the light converting layer **230** shown in FIG. 9. As shown in FIG. 2, the light converting layer **130a** as the light converting layer **230** may include the transparent substrate **131a**, the light converting film **132a** that is coated on the transparent substrate **131a** and includes semiconductor nanocrystals, and the barrier layer **135a** that is disposed on the light converting film **132a**. In this case, since the transparent substrate **131a** is a substrate that may reduce or effectively prevent penetration of external moisture or oxygen, the barrier layer **135a** may be disposed on only a top surface of the light converting film **132a**.

[0098] As shown in FIG. 3, the light converting layer **130b** as the light converting layer **230** may include the light converting film **132b** that includes semiconductor nanocrystals, and the barrier layer **135b** that is disposed on one or more surface of the light converting film **132b**. As shown in FIG. 5, the light converting layer **130f** as the light converting layer **230** may convert incident light into white light, and may reduce or effectively prevent penetration of external moisture and oxygen thereto. Each of moisture and oxygen transmission rates of the light converting film **132f** may be equal to or less than, for example, about 0.1 cc/m²/day. As shown in FIG. 6, the light converting layer **130g** as the light converting layer **230** may include the transparent substrate **131g**, and the light converting film **132g** that is disposed on the transparent substrate **131g** and includes semiconductor nanocrystals and a barrier material. As shown in FIG. 7, the light converting layer **130h** as the light converting layer **230** may include a light converting film **132h** that includes semiconductor nanocrystals and a barrier material, and the barrier layer **135h** that is disposed on one or more surface of the light converting film **132h** and includes a barrier material. The barrier layer **135h** may reduce or effectively prevent penetration of moisture or oxygen thereto, and the light

converting film 132h may reduce or effectively prevent penetration of the remaining one of moisture and oxygen.

[0099] Alternatively, the LCD device shown in FIG. 9 may further include a plurality of light converting layers sequentially disposed in a direction away from the LED light source 210, for example, as shown in FIG. 8. The plurality of light converting layers may be spaced apart from one another, and a blank layer may be defined between the light converting layers. The plurality of light converting layers may be disposed to have an emission wavelength with higher energy (that is, a shorter wavelength) as a distance from the LED light source 210 increases. Arrangement structures of the plurality of light converting layers may be variously modified as described above.

[0100] An adhesive layer (not shown) including the barrier material may be further disposed on a side surface of the light converting layer 230. The adhesive layer may surround the side surface of the light converting layer 230. Due to the adhesive layer, edge portions of layers constituting the light converting layer 230 may be considered laminated. A barrier material included in the adhesive layer reduces or effectively prevents external moisture and/or oxygen from penetrating into the side surface of the light converting layer 230. The adhesive layer may have an uneven structure corresponding to the edge portions of the layers constituting the light converting layer 230, or a multi-layer structure disposed on a film.

[0101] A diffusive plate 240 is disposed between the LED light source 210 and the light converting layer 230. When light emitted from the LED light source 210 transmits through the diffusive plate 240, uniformity of the light may be improved. The light passing through the diffusive plate 240 is incident on the light converting layer 230 and is converted into white light. Although the diffusive plate 240 and the light converting layer 230 are spaced apart from each other in FIG. 9, the light converting layer 230 may contact a top surface of the diffusive plate 240.

[0102] A light guide plate 220 may be further disposed between the LED light source 210 and the diffusive plate 240.

[0103] A predetermined optical sheet 250 for improving optical properties such as brightness may be further disposed between the light converting layer 230 and the liquid crystal panel 500. Alternatively, the optical sheet 250 may be disposed between the LED light source 210 and the light converting layer 230.

[0104] FIG. 10 is a cross-sectional view illustrating another embodiment of an LCD device. The following explanation will focus on a difference from the previous embodiments.

[0105] Referring to FIG. 10, the LCD device includes a backlight unit 300, and a liquid crystal panel 500 that forms an image of a predetermined color by using white light emitted from the backlight unit 300. The backlight unit 300 includes an LED light source 310, and a light converting layer 330 that is spaced apart from the LED light source 310. The LED light source 310 may include a substrate 311, and a plurality of LEDs 312 that is disposed at predetermined intervals on the substrate 311. The LED light source 310 may be a light source that emits blue light, or a light source that emits ultraviolet light.

[0106] The light converting layer 330 includes a light-converting diffusive film 332 that includes semiconductor nanocrystals for converting incident light into white light

and light diffusing particles for diffusing incident light, and a barrier layer 335 that is disposed on one or more surface of the light-converting diffusive film 332. Each of the LED light source 310 and the light converting layer 330 may have a planar size corresponding to the liquid crystal panel 500.

[0107] The light-converting diffusive film 332 may perform both a light conversion function and a light diffusion function. The semiconductor nanocrystals may include at least one selected from a Group II-VI material, a Group III-V material, and a Group IV element. As is further disclosed above, the Group II-VI material may include at least one selected from HgTe, HgSe, HgS, CdTe, CdSe, Cds, ZnTe, ZnSe, and ZnS, the Group III-V material may include at least one selected from GaN, GaP, InN, InP, and InAs, and the Group IV element may include at least one selected from Si and Ge. The materials are exemplarily described as materials of the semiconductor nanocrystals, and other various semiconductor materials may be used as materials for the semiconductor nanocrystals.

[0108] The barrier layer 335 reduces or effectively prevents external moisture and/or oxygen from penetrating into the light-converting diffusive film 332. Each of moisture and oxygen transmission rates of the barrier layer 335 may be, but is not limited to, equal to or less than about 0.1 cc/m²/day.

[0109] A barrier material of the barrier layer 335 may include at least one selected from an organic material and an inorganic material. The barrier layer 335 may have a multi-layer structure in which at least one organic film and at least one inorganic film alternate in a stack. An adhesive layer (not shown) including the barrier material may be further disposed on a side surface of the light converting layer 330. The adhesive layer may surround the side surface of the light converting layer 330. Due to the adhesive layer, edge portions of layers constituting the light converting layer 330 may be considered laminated.

[0110] FIG. 11 is a cross-sectional view illustrating another embodiment of the light converting layer 330 of FIG. 10. Referring to FIG. 11, a light converting layer 330a may include a transparent substrate 331a, a light-converting diffusive film 332a that is coated on the transparent substrate 331a and includes semiconductor nanocrystals and light diffusing particles, and a barrier layer 335a that is disposed on a top surface of the light-converting diffusive film 332a. When the transparent substrate 331a includes a material into which moisture or oxygen may penetrate such as PET, the barrier layer 335a may also be disposed on the bottom surface of the transparent substrate 331a.

[0111] FIG. 12 is a cross-sectional view illustrating another embodiment of the light converting layer 330 of FIG. 10. Referring to FIG. 12, a light converting layer 330b may include a transparent substrate 331b, a light-converting diffusive film 332b that is coated on the transparent substrate 331b and includes semiconductor nanocrystals and light diffusing particles, and a barrier layer 335b that is disposed on a top surface of the light-converting diffusive film 332b. The transparent substrate 331b may be a substrate that reduces or effectively prevents penetration of external moisture or oxygen such as a glass substrate. In this case, the barrier layer 335b may be disposed on only the top surface of the light-converting diffusive film 332b.

[0112] FIG. 13 is a cross-sectional view illustrating another embodiment of the light converting layer 330 of FIG. 10. Referring to FIG. 13, a light converting layer 330c

may include a light-converting diffusive film **332e** that includes semiconductor nanocrystals for converting incident light into white light, light diffusing particles for diffusing incident light, and a barrier material for reducing or effectively preventing penetration of external moisture and/or oxygen thereto. The light-converting diffusive film **332e** may be a single-layer film including the semiconductor nanocrystals, the light diffusing particles and the barrier material.

[0113] FIG. 14 is a cross-sectional view illustrating another embodiment of the light converting layer **330** of FIG. 10. Referring to FIG. 14, a light converting layer **330f** may include a transparent substrate **331f**, and a light-converting diffusive film **332f** that is disposed on the transparent substrate **331f** and includes semiconductor nanocrystals, light diffusing particles and a barrier material.

[0114] FIG. 15 is a cross-sectional view illustrating another embodiment of the light converting layer **330** of FIG. 10. Referring to FIG. 15, a light converting layer **330g** may include a light-converting diffusive film **332g** that includes semiconductor nanocrystals, light diffusing particles and a barrier material, and a barrier layer **335g** that is disposed on one or more surface of the light-converting diffusive film **332g** and includes a barrier material. In this case, the barrier layer **335g** may reduce or effectively prevent penetration of moisture or oxygen, and the light-converting diffusive film **332g** may reduce or effectively prevent penetration of the remaining one of moisture and oxygen.

[0115] FIG. 16 is a cross-sectional view illustrating another embodiment of the light converting layer **330** of FIG. 10. Referring to FIG. 16, the LCD device may include a plurality of light converting layers sequentially disposed in a direction away from the LED light source **310**. In detail, first and second light converting layers **330c** and **330d** are sequentially disposed in a direction away from the LED light source **310**.

[0116] The first light converting layer **330c** may include a first light-converting diffusive film **332c**, and a first barrier layer **335c** that is disposed on one or more surface of the first light-converting diffusive film **332c**. The second light converting layer **330d** may include a second light-converting diffusive film **332d**, and a second barrier layer **335d** that is disposed on one or more surface of the second light-converting diffusive film **332d**.

[0117] The first light converting layer **330c** and the second light converting layer **330d** may be spaced apart from each other, and a blank layer **336** may be defined between the first light converting layer **330c** and the second light converting layer **330d**. The first and second light converting layers **330c** and **330d** may be disposed to have an emission wavelength with higher energy (that is, a shorter wavelength) as a distance from the LED light source **310** increases. In one embodiment, for example, when the LED light source **310** is a blue LED light source, the first and second light converting layers **330c** and **330d** which are sequentially disposed in a direction away from the LED light source **310** may be a red light converting layer and a green light converting layer, respectively.

[0118] Alternatively, the LCD device or a light converting member of the LCD device may include three or more sequential light converting layers. The three or more light converting layers may have any of the following arrangement structures. In alternative embodiments, for example,

the light converting layers may have an arrangement structure of the LED light source **310**—red light converting layer—green light converting layer—red light converting layer—green light converting layer, an arrangement structure of the LED light source **310**—green light converting layer—red light converting layer—green light converting layer—red light converting layer, an arrangement structure of the LED light source **310**—red light converting layer—orange light converting layer—yellow light converting layer—green light converting layer, or an arrangement structure of the LED light source **310**—red+yellow light converting layer—green+orange light converting layer. The aforesaid arrangement structures of the three or more sequential light converting layers are exemplary, and the three or more sequential light converting layers may have any of various other arrangement structures.

[0119] Referring back to FIG. 10, when light emitted from the LED light source **310** passes through the light-converting diffusive film **332** that includes the semiconductor nanocrystals and the light diffusing particles, white light that is a mixture of blue light, green light and red light may be obtained. When compositions and/or sizes of the semiconductor nanocrystals included in the light-converting diffusive film **332** are changed, the blue light, the green light and the red light may be adjusted at a desired ratio, and thus white light having high color reproducibility and high color purity may be obtained.

[0120] A light guide plate **320** may be further disposed between the LED light source **310** and the light converting layer **330**. The light guide plate **320** uniformly guides light output from the LED light source **310** toward the light converting layer **330**.

[0121] A predetermined optical sheet **350** for improving optical properties such as brightness may be further disposed between the light converting layer **330** and the liquid crystal panel **500**. The optical sheet **350** may include, but is not limited to, at least one selected from, for example, a prism sheet, a brightness enhancement sheet and a micro-lens sheet. Alternatively, the optical sheet **350** may be disposed between the LED light source **310** and the light converting layer **330**.

[0122] White light emitted from the backlight unit **300** is incident on the liquid crystal panel **500**. The liquid crystal panel **500** forms an image of a predetermined color by using the white light incident from the backlight unit **300**. The liquid crystal panel **500** may have a structure in which a first polarization plate **510**, a liquid crystal layer **520**, a second polarization plate **530** and a color filter **540** are sequentially disposed. The white light emitted from the backlight unit **300** transmits through the first polarization plate **510**, the liquid crystal layer **520** and the second polarization plate **530**, and then is incident on the color filter **540**, to form the image of the predetermined color.

[0123] FIG. 17 is a cross-sectional view illustrating another embodiment of an LCD device. The following explanation will focus on a difference from the previous embodiments.

[0124] Referring to FIG. 17, the LCD device includes a backlight unit **800**, and the liquid crystal panel **500** that forms an image of a predetermined color by using white light emitted from the backlight unit **800**. The backlight unit **800** includes an LED light source **810**, a light guide plate **820** that is disposed between the LED light source **810** and

the liquid crystal panel **500**, and a barrier layer **835** that is disposed on one or more surface of the light guide plate **820**.

[0125] The LED light source **810** may include a substrate **811**, and a plurality of LEDs **812** that is disposed at predetermined intervals on the substrate **811**. The LED light source **810** may be a light source that emits blue light, or a light source that emits ultraviolet light.

[0126] The light guide plate **820** that guides light incident from the LED light source **810** toward the liquid crystal panel **500** may include semiconductor nanocrystals. Accordingly, the light guide plate **820** converts incident light into white light and guides the white light toward the liquid crystal panel **500**. The barrier layer **835** is disposed on one or more surface of the light guide plate **820**, and reduces or effectively prevents external moisture and/or oxygen from penetrating into the light guide plate **820**. Each of moisture and oxygen transmission rates of the barrier layer **835** may be equal to or less than, for example, about 0.1 cc/m²/day. However, the present embodiment is not limited thereto, and each of moisture and oxygen transmission rates of the barrier layer **835** may be another value which sufficiently restricts the moisture and the oxygen, respectively.

[0127] A barrier material of the barrier layer **835** may include at least one selected from an organic material and an inorganic material. The organic material may include at least one selected from, for example, thiolene, hybrid epoxy, polyurea, PTFE, PDMS, polyvinylchloride, polycarbonate, polystyrene, polyimide, parylene, polyethylacrylate, and polymethylmethacrylate. The inorganic material may include at least one selected from, for example, silicon oxide, aluminum oxide, titanium oxide, indium oxide, tin oxide, tin indium oxide, tantalum oxide, zirconium oxide, and niobium oxide. However, the present embodiment is not limited thereto, and any of various other organic materials or inorganic materials may be used as the barrier material. The barrier layer **835** may have a structure in which at least one organic film and at least one inorganic film alternate in a stack.

[0128] An adhesive layer (not shown) including the barrier material may be further disposed on a side surface of the light guide plate **820**. The adhesive layer may surround the side surface of the light guide plate **820**. The barrier material included in the adhesive layer reduces or effectively prevents external moisture and/or oxygen from penetrating into the side surface of the light guide plate **820**. The barrier material may include at least one selected from an organic material and an inorganic material.

[0129] A diffusive plate **840** may be further disposed between the light guide plate **820** and the liquid crystal panel **500**. Since the diffusive plate **840** diffuses white light incident from the light guide plate **820** and outputs the white light, uniformity of the white light passing through the diffusive plate **840** may be improved.

[0130] A predetermined optical sheet **850** for improving optical properties such as brightness may be further disposed between the diffusive plate **840** and the liquid crystal panel **500**. The optical sheet **850** may include, but is not limited to, at least one selected from a prism sheet, a brightness enhancement sheet or a micro-lens sheet.

[0131] FIG. **18** is a cross-sectional view illustrating another embodiment of an LCD device. The following explanation will focus on a difference from the previous embodiments.

[0132] Referring to FIG. **18**, the LCD device includes a backlight unit **900**, and a liquid crystal panel **500** that forms an image of a predetermined color by using white light emitted from the backlight unit **900**. The backlight unit **900** includes an LED light source **910**, a light guide plate **920** that is disposed between the LED light source **910** and the liquid crystal panel **500**, and a barrier layer **935** that is disposed on one or more surface of the light guide plate **920**.

[0133] The LED light source **910** may include a substrate **911**, and a plurality of LEDs **912** that is disposed at predetermined intervals on the substrate **911**. The LED light source **910** may be a light source that emits blue light, or a light source that emits ultraviolet light.

[0134] The light guide plate **920** that guides light incident from the LED light source **910** toward the liquid crystal panel **500** may include semiconductor nanocrystals and light diffusing particles. Accordingly, the light guide plate **920** may convert incident light into white light, diffuse the white light and guide the diffused white light toward the liquid crystal panel **500**.

[0135] An adhesive layer (not shown) including a barrier material may be further disposed on a side surface of the light guide plate **920**.

[0136] A predetermined optical sheet **950** for improving optical properties such as brightness may be further disposed between the light guide plate **920** and the liquid crystal panel **500**. The optical sheet **950** may include, but is not limited to, at least one selected from a prism sheet, a brightness enhancement sheet or a micro-lens sheet.

[0137] FIG. **19** is a cross-sectional view illustrating another embodiment of an LCD device.

[0138] Referring to FIG. **19**, the LCD device includes a backlight unit **400**, and the liquid crystal panel **500** that forms an image of a predetermined color by using white light emitted from the backlight unit **400**. The backlight unit **400** includes an LED light source **410**, a light guide plate **420** that uniformly guides light emitted from the LED light source **410** toward the liquid crystal panel **500**, and a light converting layer **430** that converts light emitted from the light guide plate **420** into white light.

[0139] The LED light source **410** may be disposed on one or more side of the light guide plate **420**. The light guide plate **420** may include an upper surface as a light emitting surface, a lower surface as a rear transmitting or reflecting surface, and a plurality of side surfaces connecting the upper and lower surfaces to each other. One more of the side surfaces which faces the LED light source **410** may be a light incident surface of the light guide plate **420**.

[0140] The LED light source **410** may include a substrate **411**, and a plurality of LEDs **412** that is disposed at predetermined intervals on the substrate **411**. The LED light source **410** may be a light source that emits blue light, or a light source that emits ultraviolet light. A reflective plate **415** for reflecting light output from the light guide plate **420** to the liquid crystal panel **500** may be further disposed under the light guide plate **420**.

[0141] The light converting layer **430** converts light incident from the light guide plate **420** into white light, and emits the white light to the liquid crystal panel **500**. The light converting layer **430** may have a planar size corresponding to the liquid crystal panel **500**. The light converting layer **430** may include a transparent substrate **431**, a light converting film **432** that is disposed such as by coating on the transparent substrate **431** and includes semiconductor

nanocrystals, and a barrier layer **435** that is disposed on a top surface of the light converting film **432** and includes a barrier material.

[0142] The light converting film **432** may include semiconductor nanocrystals that may ensure high color reproducibility and high color purity. The light converting film **432** may be, for example, a polymer film in which the semiconductor nanocrystals are dispersed. The barrier layer **435** may be disposed on the top surface of the light converting film **432**. The barrier layer **435** reduces or effectively prevents external moisture and/or oxygen from penetrating into the light converting film **432**. When the transparent substrate **431** includes of a material in which moisture or oxygen may penetrate such as PET, the barrier layer **435** may also be disposed on the bottom surface of the transparent substrate **431**.

[0143] Each of moisture and oxygen transmission rates of the barrier layer **435** may be equal to or less than, for example, about 0.1 cc/m²/day. The present embodiment is not limited thereto, and each of moisture and oxygen transmission rates of the barrier layer **435** may be another value which sufficiently restricts the moisture and the oxygen, respectively.

[0144] The barrier material of the barrier layer **435** may include at least one selected from an organic material and an inorganic material. The organic material may include at least one selected from, for example, thiolene, hybrid epoxy, polyurea, PTFE, PDMS, polyvinylchloride, polycarbonate, polystyrene, polyimide, parylene, polyethylacrylate, and polymethylmethacrylate. The inorganic material may include at least one selected from, for example, silicon oxide, aluminum oxide, titanium oxide, indium oxide, tin oxide, tin indium oxide, tantalum oxide, zirconium oxide, and niobium oxide. However, the present embodiment is not limited thereto, and any of various other organic materials or inorganic materials may be used as the barrier material. The barrier layer **435** may have a structure in which at least one organic film and at least one inorganic film alternate in a stack.

[0145] When a general or conventional backlight unit that does not include the barrier layer **435** is driven for a long time, for example, 100 hours or more, at a temperature higher than a room temperature, brightness of white light may be reduced by 10% or more, a change (ΔC_x , ΔC_y) in color coordinates may be greater than (± 0.1 , ± 0.1), or a change in a color temperature may be 1000° K or more. However, when the backlight unit **400** including the barrier layer **435** whose moisture transmission rate and oxygen transmission rates are each equal to or less than about 0.1 cc/m²/day is driven for a long time, for example, 100 hours or more, at a temperature higher than a room temperature, brightness of white light may be maintained, a change (ΔC_x , ΔC_y) in color coordinates may be less than (± 0.1 , ± 0.1), and/or a change in a color temperature may be 1000° K or less.

[0146] Various modified examples of the light converting layer **430** are illustrated in FIGS. 2, 3, 5, 6 and 7, and a detailed explanation thereof has already been made and thus will not be repeated here. The LCD device of FIG. 19 may further include a plurality of light converting layers sequentially disposed in a direction away from the LED light source **410** and/or the light guide plate **420**. The light converting layers may be spaced apart from one another, and a blank layer may be defined between the plurality of light convert-

ing layers. The plurality of light converting layers may be disposed to have an emission wavelength with higher energy (that is, a shorter wavelength) as a distance from the LED light source **410** and/or the light guide plate **420** increases. Arrangement structures of the plurality of light converting layers may be variously modified as described above.

[0147] An adhesive layer (not shown) including the barrier material may be further disposed on a side surface of the light converting layer **430**. The adhesive layer may surround the side surface of the light converting layer **430**. Due to the adhesive layer, edge portions of layers constituting the light converting layer **430** may be considered laminated. The barrier material included in the adhesive layer reduces or effectively prevents external moisture and/or oxygen from penetrating into the side surface of the light converting layer **430**. The adhesive layer may have an uneven structure corresponding to the edge portions of the layers constituting the light converting layer **430**, or a multi-layer structure disposed on a film. The barrier material may include at least one selected from an organic material and an inorganic material.

[0148] When light emitted from the LED light source **410** passes through the light guide plate **420** and the light converting film **432**, white light that is a mixture of blue light, green light and red light may be obtained. When compositions and/or sizes of the semiconductor nanocrystals included in the light converting film **432** are changed, the blue light, the green light and the red light may be adjusted at a desired ratio, and thus white light having high color reproducibility and high color purity may be obtained.

[0149] A diffusive plate **440** may be further disposed between the light converting layer **430** and the liquid crystal panel **500**. The diffusive plate **440** diffuses white light incident from the light converting layer **430** and outputs the white light. Accordingly, uniformity of the white light passing through the diffusive plate **440** may be improved. Although the diffusive plate **440** and the light converting layer **430** are spaced apart from each other in FIG. 19, the light converting layer **430** may contact a bottom surface of the diffusive plate **440**.

[0150] A predetermined optical sheet **450** for improving optical properties such as brightness may be further disposed between the diffusive plate **440** and the liquid crystal panel **500**. The optical sheet **450** may include, but is not limited to, at least one selected from a prism sheet, a brightness enhancement sheet and a micro-lens sheet.

[0151] FIG. 20 is a cross-sectional view illustrating another embodiment of an LCD device. The following explanation will focus on a difference from the previous embodiments.

[0152] Referring to FIG. 20, the LCD device includes a backlight unit **600**, and a liquid crystal panel **500** that forms an image of a predetermined color by using white light emitted from the backlight unit **600**. The backlight unit **600** includes an LED light source **610**, a light guide plate **620** that uniformly guides light emitted from the LED light source **610** toward the liquid crystal panel **500**, and a light converting layer **630** that converts light emitted from the light guide plate **620** into white light.

[0153] The LED light source **610** may be disposed on one or more side of the light guide plate **620**, and a reflective plate **615** may be further disposed under the light guide plate **620**. The LED light source **610** may be a light source that emits blue light, or a light source that emits ultraviolet light.

The LED light source **610** may include a substrate **611**, and a plurality of LEDs **612** that is disposed at predetermined intervals on the substrate **611**.

[0154] The light converting layer **630** which converts light incident from the LED light source **610** into white light is disposed between the light guide plate **620** and the liquid crystal panel **500**. The light converting layer **630** may include a transparent substrate **631**, a light converting film **632** that is coated on the transparent substrate **631** and includes semiconductor nanocrystals, and a barrier layer **635** that is disposed on a top surface of the light converting film **632**. The barrier layer **635** reduces or effectively prevents external moisture and/or oxygen from penetrating into the light converting film **632**. When the transparent substrate **631** includes a material into which moisture or oxygen may penetrate such as PET, the barrier layer **635** may also be disposed on the bottom surface of the transparent substrate **631**.

[0155] Each of moisture and oxygen transmission rates of the barrier layer **635** may be, but is not limited to, equal to or less than about 0.1 cc/m²/day. A barrier material of the barrier layer **635** may include at least one selected from an organic material and an inorganic material. The barrier layer **635** may have a structure in which at least one organic film and at least one inorganic film alternate in a stack.

[0156] Various modified examples of the light converting layer **630** are illustrated in FIGS. 2, 3, 5, 6 and 7, and a detailed explanation thereof has already been made and thus will not be repeated here. The LCD device of FIG. 20 may further include a plurality of light converting layers sequentially disposed in a direction away from the LED light source **610** and/or the light guide plate **620**. The plurality of light converting layers may be spaced apart from one another, and a blank layer may be defined between the plurality of light converting layers. The plurality of light converting layers may be disposed to have an emission wavelength with higher energy (that is, a shorter wavelength) as a distance from the LED light source **610** and/or the light guide plate **620** increases. Arrangement structures of the plurality of light converting layers may be variously modified as described above.

[0157] An adhesive layer (not shown) including the barrier material may be further disposed on a side surface of the light converting layer **630**. The adhesive layer may surround the side surface of the light converting layer **630**. The barrier material may include at least one selected from an organic material and an inorganic material.

[0158] A diffusive plate **640** may be further disposed between the LED light source **610** and the light converting layer **630**. Uniformity of light emitted from the LED light source **610** may be improved while passing through the diffusive plate **640**, and the light passing through the diffusive plate **640** may be incident on the light converting layer **630** may be converted into white light. Although the diffusive plate **640** and the light converting layer **630** are spaced apart from each other in FIG. 12, the light converting layer **630** may contact a top surface of the diffusive plate **640**.

[0159] A predetermined optical sheet **650** for improving optical properties such as brightness may be further disposed between the light converting layer **630** and the liquid crystal panel **500**.

[0160] FIG. 21 is a cross-sectional view illustrating another embodiment of an LCD device. The following explanation will focus on a difference from the previous embodiments.

[0161] Referring to FIG. 21, the LCD device includes a backlight unit **700**, and the liquid crystal panel **500** that forms an image of a predetermined color by using white light emitted from the backlight unit **700**. The backlight unit **700** includes an LED light source **710**, a light guide plate **720** that uniformly guides light emitted from the LED light source **710** toward the liquid crystal panel **500**, and a light converting layer **730** that converts light emitted from the light guide plate **720** into white light.

[0162] The LED light source **710** may be disposed on one or more side of the light guide plate **720**, and a reflective plate **715** may be further disposed under the light guide plate **720**. The LED light source **710** may be a light source that emits blue light, or a light source that emits ultraviolet light. The LED light source **710** may include a substrate **711**, and a plurality of LEDs **712** that is disposed at predetermined intervals on the substrate **711**.

[0163] The light converting layer **730** is disposed between the light guide plate **720** and the liquid crystal panel **500**. The light converting layer **730** includes a diffusive film **732** that includes semiconductor nanocrystals for converting incident light into white light and light diffusing particles for diffusing incident light, and a barrier layer **735** that is disposed on one or more surface of the light-converting diffusive film **732**. The light-converting diffusive film **732** may convert light into white light and diffuse light.

[0164] Each of moisture and oxygen transmission rates of the barrier layers **735** may be, but is not limited to, equal to or less than about 0.1 cc/m²/day.

[0165] Various modified examples of the light converting layer **730** are illustrated in FIGS. 11 through 15, and a detailed explanation thereof has already been made and thus will not be repeated here. The LCD device of FIG. 21 may include a plurality of light converting layers sequentially disposed in a direction away from the LED light source **710** and/or the light guide plate **720**. The plurality of light converting layers may be spaced apart from one another, and a blank layer may be defined between the plurality of light converting layers. The plurality of light converting layers may be disposed to have an emission wavelength with higher energy (that is, a shorter wavelength) as a distance from the LED light source **710** and/or the light guide plate **720** increases. Arrangement structures of the plurality of light converting layers may be variously modified as described above.

[0166] A predetermined optical sheet **750** for improving optical properties such as brightness may be further disposed between the light converting layer **730** and the liquid crystal panel **500**.

[0167] An adhesive layer (not shown) including the barrier material may be further formed on a side surface of the light converting layer **730**. The adhesive layer may surround the side surface of the light converting layer **730**.

[0168] FIG. 22 is a cross-sectional view illustrating another embodiment of an LCD device. The following explanation will focus on a difference from the previous embodiments.

[0169] Referring to FIG. 22, the LCD device includes a backlight unit **1100**, and the liquid crystal panel **500** that forms an image of a predetermined color by using white

light emitted from the backlight unit **1100**. The backlight unit **1100** includes an LED light source **1110**, and a light guide plate **1120** that uniformly guides light emitted from the LED light source **1110** toward the liquid crystal panel **500**.

[0170] The LED light source **1110** may be disposed on one or more side of the light guide plate **1120**, and a reflective plate **1115** may be further disposed under the light guide plate **1120**. The LED light source **1110** may be a light source that emits blue light, or a light source that emits ultraviolet light. The LED light source **1110** may include a substrate **1111**, and a plurality of LEDs **1112** that is disposed at predetermined intervals on the substrate **1111**.

[0171] The light guide plate **1120** for guiding light incident from the LED light source **1110** toward the liquid crystal panel **500** may include semiconductor nanocrystals. Accordingly, the light guide plate **1120** may convert incident light into white light, and may guide light toward the liquid crystal panel **500**. A barrier layer **1135** is disposed on one or more surface of the light guide plate **1120**, and reduces or effectively prevents external moisture and/or oxygen from penetrating into the light guide plate **1120**.

[0172] A diffusive plate **1140** may be further disposed between the light guide plate **1120** and the liquid crystal panel **500**. The diffusive plate **1140** may diffuse white light incident from the light guide plate **1120** and outputs the diffused white light. Accordingly, uniformity of the white light passing through the diffusive plate **1140** may be improved.

[0173] A predetermined optical sheet **1150** for improving optical properties such as brightness may be further disposed between the diffused plate **1140** and the liquid crystal panel **500**. The optical sheet **1150** may include at least one selected from, for example, a prism sheet, a brightness enhancement sheet and a micro-lens sheet.

[0174] An adhesive layer (not shown) including the barrier material may be further disposed on a side surface of the light guide plate **1120**. The adhesive layer may surround the side surface of the light guide plate **1120**.

[0175] FIG. 23 is a cross-sectional view illustrating another embodiment of an LCD device. The following explanation will focus on a difference from the previous embodiments.

[0176] Referring to FIG. 23, the LCD device includes a backlight unit **1200**, and the liquid crystal panel **500** that forms an image of a predetermined color by using white light emitted from the backlight unit **1200**. The backlight unit **1200** includes an LED light source **1210**, and a light guide plate **1220** that uniformly guides light emitted from the LED light source **1210** toward the liquid crystal panel **500**.

[0177] The LED light source **1210** may be disposed on one or more side of the light guide plate **1220**, and a reflective plate **1215** may be further disposed under the light guide plate **1220**. The LED light source **1210** may be a light source that emits blue light, or a light source that emits ultraviolet light. The LED light source **1210** may include a substrate **1211**, and a plurality of LEDs **1212** that is disposed at predetermined intervals on the substrate **1211**.

[0178] The light guide plate **1220** that guides light incident from the LED light source **1210** toward the liquid crystal panel **500** may include semiconductor nanocrystals for converting incident light into white light and light diffusing particles for diffusing incident light. Accordingly, the light

guide plate **1220** may convert incident light into white light, diffuse the white light, and guide the diffused white light toward the liquid crystal panel **500**. A barrier layer **1235** is disposed on one or more surface of the light guide plate **1220**, and reduces or effectively prevents external moisture and/or oxygen from penetrating into the light guide plate **1220**.

[0179] A predetermined optical sheet **1250** for improving optical properties such as brightness may be further disposed between the light guide plate **1220** and the liquid crystal panel **500**. The optical sheet **1250** may include, but is not limited to, at least one selected from a prism sheet, a brightness enhancement sheet and a micro-lens sheet.

[0180] An adhesive layer (not shown) including the barrier layer may be further disposed on a side surface of the light guide plate **1220**. The adhesive layer may surround the side surface of the light converting layer **1220**.

[0181] According to the one or more embodiments, since a light converting layer for converting incident light into white light includes semiconductor nanocrystals, color reproducibility and color purity of white light may be improved. Since the light converting layer including the semiconductor nanocrystals is spaced apart from an LED light source, deterioration of the semiconductor nanocrystals due to heat generated from LEDs of the light source is reduced or effectively prevented. Also, since the light converting layer includes a barrier material, penetration of external moisture or oxygen into the semiconductor nanocrystals is reduced or effectively prevented. Accordingly, when the light converting layer converts incident light into white light, optical properties such as a wavelength, a full width at half maximum or quantum efficiency may not be changed, and thus brightness and color coordinates of white light may be maintained even when a backlight unit is driven for a long time.

[0182] While the invention has been particularly shown and described with reference to embodiments thereof, these embodiments are provided for the purposes of illustration and it will be understood by those of ordinary skill in the art that various modifications and equivalent other embodiments can be made from the invention.

What is claimed is:

1. A display device comprising:

a semiconductor nanocrystal composite comprising semiconductor nanocrystals and a barrier material having a moisture transmission rate and an oxygen transmission rate of equal to or less than about 0.1 cc/m²/day.

2. The display device of claim 1, further comprising a light source generating and emitting light, wherein the semiconductor nanocrystal composite converts the light from the light source into another light.

3. The display device of claim 2, wherein the semiconductor nanocrystal composite has a shape of film.

4. The display device of claim 3, wherein the semiconductor nanocrystal composite comprises at least one layer including the semiconductor nanocrystals and at least one layer including the barrier material.

5. The display device of claim 3, wherein the semiconductor nanocrystal composite comprises at least one layer including the semiconductor nanocrystals and the barrier material.

6. The display device of claim 2, wherein the semiconductor nanocrystals comprise at least one selected from a Group II-VI material, a Group III-V material, and a Group IV element.

7. The display device of claim 2, wherein the barrier material comprises at least one selected from an organic material and an inorganic material.

8. The display device of claim 2, wherein the light source comprises a light-emitting diode.

9. The display device of claim 8, wherein the semiconductor nanocrystal composite is configured to be spaced apart from the light source.

10. The display device of claim 2, further comprising a liquid crystal panel forming an image by using another light emitted from the semiconductor nanocrystal composite.

11. The display device of claim 10, further comprising a transparent substrate which at least one of the semiconductor nanocrystals and the barrier material is disposed.

12. The display device of claim 11, wherein the transparent substrate comprises polyethylene terephthalate.

13. The display device of claim 10, further comprising a diffusive plate between the light source and the semiconductor nanocrystal composite or between the semiconductor nanocrystal composite and the liquid crystal panel.

14. The display device of claim 10, wherein the semiconductor nanocrystal composite further comprises light diffusing particles which diffuse the light.

15. The display device of claim 14, wherein the semiconductor nanocrystal composite comprises at least one layer including the semiconductor nanocrystals and the light diffusing particles, and at least one layer including the barrier material.

16. The display device of claim 14, wherein the semiconductor nanocrystal composite comprises at least one layer including the semiconductor nanocrystals and the light diffusing particles and the barrier material.

17. The display device of claim 10, further comprising a light guide plate between the light source and the semiconductor nanocrystal composite, wherein the light guide plate guides the light emitted from the light source toward the semiconductor nanocrystal composite.

18. The display device of claim 17, wherein the light guide plate comprises a light emitting first surface, a second surface opposite to the light emitting first surface, and a side surface connecting the first and second surfaces to each other, and the light source faces the side surface of the light guide plate.

19. A semiconductor nanocrystal composite comprising: semiconductor nanocrystals; and a barrier material having a moisture transmission rate and an oxygen transmission rate of equal to or less than about 0.1 cc/m²/day.

20. The semiconductor nanocrystal composite of claim 19, wherein the semiconductor nanocrystal composite has a shape of film.

21. The semiconductor nanocrystal composite of claim 20, wherein the semiconductor nanocrystal composite comprises at least one layer including the semiconductor nanocrystals and at least one layer including the barrier material.

22. The semiconductor nanocrystal composite of claim 20, wherein the semiconductor nanocrystal composite comprises at least one layer including the semiconductor nanocrystals and the barrier material.

23. The semiconductor nanocrystal composite of claim 19, wherein the semiconductor nanocrystals comprise at least one selected from a Group II-VI material, a Group III-V material, and a Group IV element.

24. The semiconductor nanocrystal composite of claim 19, wherein the barrier material comprises at least one selected from an organic material and an inorganic material.

25. The semiconductor nanocrystal composite of claim 24, wherein the organic material comprises at least one selected from thiolene, hybrid epoxy, polyurea, polytetrafluoroethylene, polydimethylsiloxane, polyvinylchloride, polycarbonate, polystyrene, polyimide, parylene, polyethylacrylate, and polymethylmethacrylate.

26. The semiconductor nanocrystal composite of claim 24, wherein the inorganic material comprises at least one selected from silicon oxide, aluminum oxide, titanium oxide, indium oxide, tin oxide, indium oxide, tantalum oxide, zirconium oxide, and niobium oxide.

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专利名称(译)	背光单元和包括其的液晶显示装置		
公开(公告)号	US20180180944A1	公开(公告)日	2018-06-28
申请号	US15/887015	申请日	2018-02-02
[标]申请(专利权)人(译)	三星电子株式会社		
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发明人	JANG, EUN-JOO KANG, HYUN-A CHO, OUL		
IPC分类号	G02F1/1335 F21V8/00		
CPC分类号	G02F2202/36 G02F2001/133614 G02F1/133606 G02B6/005 G02B6/0051 G02F1/133603 B82Y20/00 G02B6/0003 G02B6/0068 G02B6/0073 Y10S977/834 G02F1/133617		
优先权	1020120099549 2012-09-07 KR		
外部链接	Espacenet USPTO		

摘要(译)

一种用于包括液晶面板的液晶显示装置的背光单元，包括：光源，包括产生和发光的发光二极管（“ED”）；光源和液晶面板之间的光转换层，与光源间隔开，并将来自光源的光转换成白光，并将白光发射到液晶面板。光转换层包括：半导体纳米晶体和限制水分或氧气渗透的阻挡材料。

